# LXT386 QUAD T1/E1/J1 Transceiver

## Datasheet

The LXT386 is a quad short haul Pulse Code Modulation (PCM) transceiver for use in both 1.544 Mbps (T1) and 2.048 Mbps (E1) applications. It incorporates four independent receivers and four independent transmitters in a single PBGA-160 or LQFP-100 package.

The transmit drivers provide low impedance independent of the transmit pattern and supply voltage variations. The LXT386 transmits shaped waveforms meeting G.703 and T1.102 specifications. The LXT386 exceeds the latest transmit return loss specifications, such as ETSI ETS-300166.

The LXT386's differential receiver architecture provides high noise interference margin and is able to work with up to 12 dB of cable attenuation. The digital clock recovery PLL and jitter attenuator are referenced to a low frequency 1.544 MHz or 2.048 MHz clock.

The LXT386 incorporates an advanced crystal-less jitter attenuator switchable between the receive and transmit path. The jitter attenuation performance meets the latest international specifications such as CTR12/13. The jitter attenuation performance was optimized for Synchronous Optical NETwork/Synchronous Digital Hierarchy (SONET/SDH) applications.

The LXT386 can be configured as a 3 channel transceiver with G.772 compliant non intrusive protected monitoring points. It uses a single 3.3V supply for low power consumption.

The constant delay characteristic of the LXT386 JA as well as a power down mode of all transmitters allows the implementation of Hitless Protection Switching (HPS) applications without the use of relays.

# **Applications**

- SONET/SDH tributary interfaces
- Digital cross connects
- Public/private switching trunk line interfaces
- Microwave transmission systems
- M13, E1-E3 MUX

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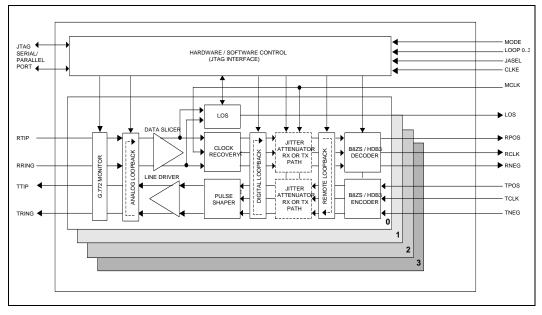
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# **1.0 Features**

- Single rail 3.3V supply with 5V tolerant inputs
- Low power consumption of 150mW per channel (typical)
- Superior crystal-less jitter attenuator
  - Meets ETSI CTR12/13, ITU G.736, G.742, G.823 and AT&T Pub 62411 specifications
  - Optimized for SONET/SDH applications, meets ITU G.783 mapping jitter specification
  - Constant throughput delay jitter attenuator
- Hitless Protection Switching (HPS) for 1 to 1 protection without relays
- HDB3, B8ZS, or AMI line encoder/decoder
- Provides protected monitoring points per ITU G.772
- Analog/digital and remote loopback testing functions
- LOS per ITU G.775, ETS 300 233 and T1.231
- 8 bit parallel or 4 wire serial control interface
- Hardware and Software control modes
- JTAG Boundary Scan test port per IEEE 1149.1
- 160 PBGA and 100 pin LQFP packages

#### Figure 1. LXT386 Block Diagram



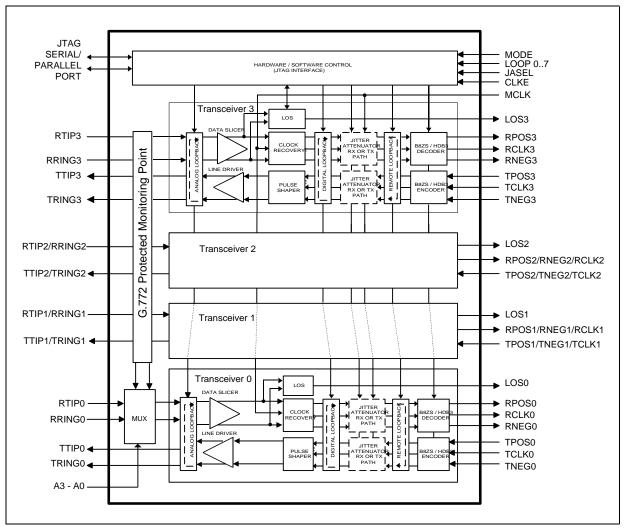


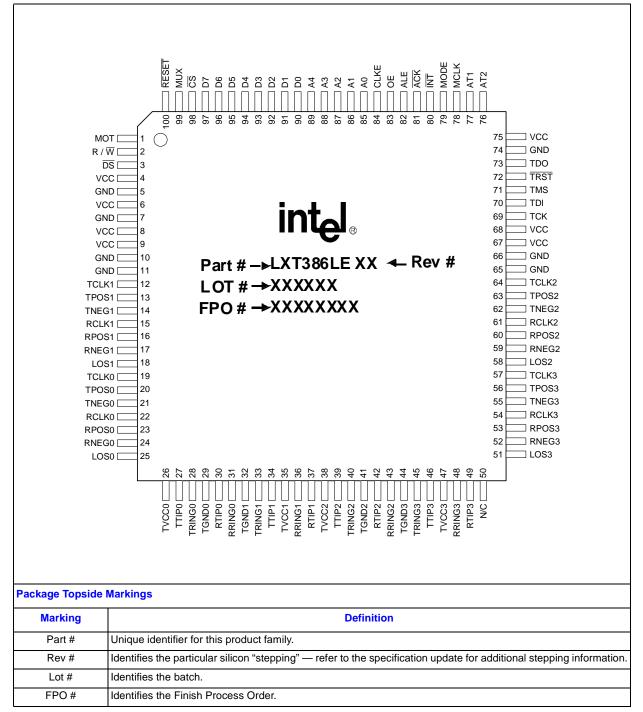
Figure 2. LXT386 Detailed Block Diagram

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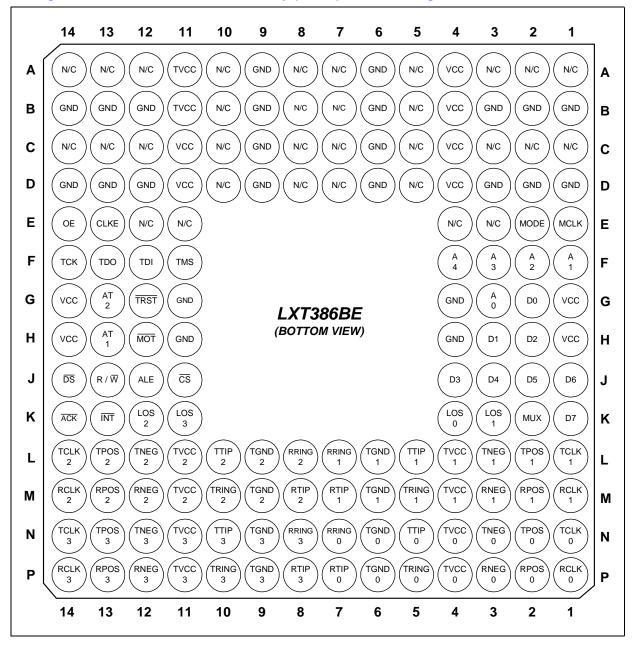
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# 2.0 Pin Assignments and Signal Description











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E1	78	MCLK	DI	<ul> <li>Master Clock. MCLK is an independent, free-running reference clock. It's frequency should be 1.544 MHz for T1 operation and 2.048 MHz for E1 operation.</li> <li>This reference clock is used to generate several internal reference signals: <ul> <li>Timing reference for the integrated clock recovery unit</li> <li>Timing reference for the integrated digital jitter attenuator</li> <li>Generation of RCLK signal during a loss of signal condition</li> <li>Reference clock during a blue alarm transmit all ones condition</li> <li>Reference timing for the parallel processor wait state generation logic</li> </ul> </li> <li>If MCLK is High, the PLL clock recovery circuit is disabled. In this mode, the LXT386 operates as simple data receiver.</li> <li>If MCLK is Low, the complete receive path is powered down and the output pins RCLK, RPOS and RNEG are switched to Tri-state mode.</li> <li>MCLK is not required if LXT386 is used as a simple analog front-end without clock recovery and jitter attenuation.</li> </ul> Note that wait state generation via RDY/ACK is not available if MCLK is not provided.
E2	79	MODE	DI	Mode Select. This pin is used to select the operating mode of the LXT386. In Hardware Mode, the parallel processor interface is disabled and hardwired pins are used to control configuration and report status. In Parallel Host Mode, the parallel port interface pins are used to control configuration and report status.         In Parallel Host Mode, the parallel port interface pins are used to control configuration and report status.         In Serial Host Mode the serial interface pins: SDI, SDO, SCLK and $\overline{CS}$ are used.         MODE       Operating Mode         L       Hardware Mode         H       Parallel Host Mode         Vcc/2       Serial Host Mode         For Serial Host Mode, the pin should connected to a resistive divider consisting of two 10 k $\Omega$ resistors across Vcc and Ground.
F4	89	A4	DI	Address Select. In host mode, this pin is Address 4 input pin. In hardware mode this pin must be connected to Ground.

### Table 1. Pin Assignments and Signal Descriptions

Table 1.	Pin Assignments and Signal Descriptions (Continued)
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Ball # PBGA	Pin # LQFP	Symbol	I/O <sup>1</sup>				Descript	ion					
PBGA	LQFP			intrusive m internally c routes the e circuits. Th activating t order for th data can be	Mode e mode th onitoring. onnected data from e data on he remote is operatio e observe e Low, the	ese pins a During pri to a speci the select the monit e loopback on to take d at the R e LXT386	are used to otection n fic transm ed port to or port ca for chan place). In CLK0/RP						
				A3	A2	A1	<b>A0</b>	Selection					
				0	0	0	0	No Protection Monitoring					
				0	0	0	1	Receiver 1					
				0	0	1	0	Receiver 2					
F3	88	A3 A2	A3	A3	A3	A3	DI	DI	0	0	1	1	Receiver 3
F2	87		DI	0	1	0	0	Reserved					
F1	86	A1	DI	0	1	0	1	Reserved					
G3	85	A0	DI	0	1	1	0	Reserved					
				0	1	1	1	Reserved					
				1	0	0	0	No Protection Monitoring					
				1	0	0	1	Transmitter 1					
				1	0	1	0	Transmitter 2					
				1	0	1	1	Transmitter 3					
				1	1	0	0	Reserved					
				1	1	0	1	Reserved					
				1	1	1	0	Reserved					
				1	1	1	1	Reserved					
				to analog lo <u>Host Mode</u>	tiplexed h	node.		when the respective channel is set					

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D0/LOOP0 D1/LOOP1 D2/LOOP2 D3/LOOP3 D4/DLOOP0 D5/DLOOP1 D6/DLOOP2 D7/DLOOP3	DI/O DI/O DI/O DI/O DI/O DI/O DI/O DI/O	function as a bi-c When a multipley both bi-directiona In serial Mode, D <u>Hardware Mode:</u> In hardware mod open (unconnect The LXT386 ente data on TPOS at RRING is looped data recovery more remote loopback The LXT386 ente DLOOP=0. In thi and data transmir routed back to the The LXT386 ente	Itiplexed microp directional 8-bi xed microproce al 8-bit data an D0-7 should be <u>:</u> de, the LXT386 ted). ers remote loo nd TNEG is igr d around and re ode, the pulse c. ers analog loca is mode, data r itted on TTIP a ne receive inpu ers digital loca received on TC	processor interface is selected, these pin t data port. essor interface is selected, these pins car d address inputs A0 -A7. grounded. works in normal operation if this pin is le pback mode if LOOP is Low. In this mode nored and data received on RTIP and etransmitted on TTIP and TRING. Note: i template cannot be guaranteed while in a al loopback mode if LOOP=1 and received on RTIP and RRING is ignored and TRING is internally looped around an
D1/LOOP1 D2/LOOP2 D3/LOOP3 D4/DLOOP0 D5/DLOOP1 D6/DLOOP2	DI/O DI/O DI/O DI/O DI/O DI/O	When a non-mul function as a bi- When a multipley both bi-directiona In serial Mode, D <u>Hardware Mode</u> : In hardware mod open (unconnect The LXT386 ente data on TPOS ar RRING is looped data recovery mo remote loopback The LXT386 ente DLOOP=0. In thi and data transmi routed back to th The LXT386 ente this mode, data r RCLK/RPOS/RN	directional 8-bi xed microproce al 8-bit data an 20-7 should be de, the LXT386 ted). ers remote loo nd TNEG is igr d around and re ode, the pulse c. ers analog loca is mode, data r itted on TTIP a he receive inpu ers digital loca received on TC NEG.	t data port. essor interface is selected, these pins car d address inputs A0 -A7. grounded. works in normal operation if this pin is le pback mode if LOOP is Low. In this mode hored and data received on RTIP and etransmitted on TTIP and TRING. Note: i template cannot be guaranteed while in a al loopback mode if LOOP=1 and received on RTIP and RRING is ignored and TRING is internally looped around an ts. I loopback if LOOP=1 and DLOOP=1. In ELK/TPOS/TNEG is digitally looped back
D1/LOOP1 D2/LOOP2 D3/LOOP3 D4/DLOOP0 D5/DLOOP1 D6/DLOOP2	DI/O DI/O DI/O DI/O DI/O DI/O	function as a bi-c When a multiplex both bi-directional In serial Mode, D <u>Hardware Mode:</u> In hardware mod open (unconnect The LXT386 ente data on TPOS at RRING is looped data recovery more remote loopback The LXT386 ente DLOOP=0. In thi and data transmi routed back to th The LXT386 entet this mode, data r RCLK/RPOS/RN	directional 8-bi xed microproce al 8-bit data an 20-7 should be de, the LXT386 ted). ers remote loo nd TNEG is igr d around and re ode, the pulse c. ers analog loca is mode, data r itted on TTIP a he receive inpu ers digital loca received on TC NEG.	t data port. essor interface is selected, these pins car d address inputs A0 -A7. grounded. works in normal operation if this pin is le pback mode if LOOP is Low. In this mode hored and data received on RTIP and etransmitted on TTIP and TRING. Note: i template cannot be guaranteed while in a al loopback mode if LOOP=1 and received on RTIP and RRING is ignored and TRING is internally looped around an ts. I loopback if LOOP=1 and DLOOP=1. In ELK/TPOS/TNEG is digitally looped back
D1/LOOP1 D2/LOOP2 D3/LOOP3 D4/DLOOP0 D5/DLOOP1 D6/DLOOP2	DI/O DI/O DI/O DI/O DI/O DI/O	both bi-directional In serial Mode, D <u>Hardware Mode:</u> In hardware mode open (unconnect The LXT386 ente data on TPOS at RRING is looped data recovery more remote loopback The LXT386 ente DLOOP=0. In thi and data transmi routed back to th The LXT386 ente this mode, data r RCLK/RPOS/RN	al 8-bit data an 20-7 should be <u>i</u> de, the LXT386 ted). ers remote loo nd TNEG is igr ode, the pulse c. ers analog loca is mode, data r itted on TTIP a the receive inpu ers digital loca received on TC NEG.	d address inputs A0 -A7. grounded. works in normal operation if this pin is le pback mode if LOOP is Low. In this mode hored and data received on RTIP and etransmitted on TTIP and TRING. Note: i template cannot be guaranteed while in a al loopback mode if LOOP=1 and received on RTIP and RRING is ignored and TRING is internally looped around an ts. I loopback if LOOP=1 and DLOOP=1. In ELK/TPOS/TNEG is digitally looped back
D1/LOOP1 D2/LOOP2 D3/LOOP3 D4/DLOOP0 D5/DLOOP1 D6/DLOOP2	DI/O DI/O DI/O DI/O DI/O DI/O	Hardware Mode: In hardware mode open (unconnect The LXT386 ente data on TPOS at RRING is looped data recovery mo remote loopback The LXT386 ente DLOOP=0. In thi and data transmi routed back to th The LXT386 ente this mode, data r RCLK/RPOS/RN	de, the LXT386 ted). ers remote loo nd TNEG is igr d around and re ode, the pulse c. ers analog loca is mode, data r itted on TTIP a he receive inpu ers digital loca received on TC NEG.	works in normal operation if this pin is leave pback mode if LOOP is Low. In this mode hored and data received on RTIP and etransmitted on TTIP and TRING. Note: i template cannot be guaranteed while in a al loopback mode if LOOP=1 and received on RTIP and RRING is ignored and TRING is internally looped around an ts. I loopback if LOOP=1 and DLOOP=1. In SLK/TPOS/TNEG is digitally looped back
D1/LOOP1 D2/LOOP2 D3/LOOP3 D4/DLOOP0 D5/DLOOP1 D6/DLOOP2	DI/O DI/O DI/O DI/O DI/O DI/O	In hardware mod open (unconnect The LXT386 enter data on TPOS ar RRING is looped data recovery more remote loopback The LXT386 enter DLOOP=0. In thi and data transmir routed back to th The LXT386 enter this mode, data r RCLK/RPOS/RN	de, the LXT386 ted). ers remote loo nd TNEG is igr d around and re ode, the pulse c. ers analog loca is mode, data r itted on TTIP a the receive inpu ers digital loca received on TC NEG.	pback mode if LOOP is Low. In this mode ored and data received on RTIP and etransmitted on TTIP and TRING. Note: i template cannot be guaranteed while in al loopback mode if LOOP=1 and received on RTIP and RRING is ignored and TRING is internally looped around an ts. I loopback if LOOP=1 and DLOOP=1. In LK/TPOS/TNEG is digitally looped back
D1/LOOP1 D2/LOOP2 D3/LOOP3 D4/DLOOP0 D5/DLOOP1 D6/DLOOP2	DI/O DI/O DI/O DI/O DI/O DI/O	open (unconnect The LXT386 enter data on TPOS ar RRING is looped data recovery more remote loopback The LXT386 enter DLOOP=0. In thi and data transmir routed back to the The LXT386 enter this mode, data r RCLK/RPOS/RN	ted). ers remote loo nd TNEG is igr d around and re ode, the pulse c. ers analog loca is mode, data r itted on TTIP a he receive inpu ers digital loca received on TC NEG.	pback mode if LOOP is Low. In this mode ored and data received on RTIP and etransmitted on TTIP and TRING. Note: template cannot be guaranteed while in al loopback mode if LOOP=1 and received on RTIP and RRING is ignored and TRING is internally looped around ar ts. I loopback if LOOP=1 and DLOOP=1. In LK/TPOS/TNEG is digitally looped back
D1/LOOP1 D2/LOOP2 D3/LOOP3 D4/DLOOP0 D5/DLOOP1 D6/DLOOP2	DI/O DI/O DI/O DI/O DI/O DI/O	data on TPOS an RRING is looped data recovery more remote loopback The LXT386 ente DLOOP=0. In thi and data transmir routed back to the The LXT386 ente this mode, data r RCLK/RPOS/RN	nd TNEG is igr d around and re ode, the pulse c. ers analog loca is mode, data r itted on TTIP a ne receive inpu ers digital loca received on TC NEG.	nored and data received on RTIP and etransmitted on TTIP and TRING. Note: template cannot be guaranteed while in al loopback mode if LOOP=1 and received on RTIP and RRING is ignored and TRING is internally looped around ar ts. I loopback if LOOP=1 and DLOOP=1. In LK/TPOS/TNEG is digitally looped back
D3/LOOP3 D4/DLOOP0 D5/DLOOP1 D6/DLOOP2	DI/O DI/O DI/O DI/O	DLOOP=0. In thi and data transmi routed back to th The LXT386 ente this mode, data r RCLK/RPOS/RN	is mode, data r itted on TTIP a ne receive inpu ers digital loca received on TC NEG.	received on RTIP and RRING is ignored and TRING is internally looped around an ts. I loopback if LOOP=1 and DLOOP=1. In LK/TPOS/TNEG is digitally looped back
D6/DLOOP2	DI/O	The LXT386 enter this mode, data r RCLK/RPOS/RN	ers digital loca received on TC NEG.	l loopback if LOOP=1 and DLOOP=1. In LK/TPOS/TNEG is digitally looped back
		this mode, data r RCLK/RPOS/RN	received on TC NEG.	LK/TPOS/TNEG is digitally looped back
			DLOOP	Operating Mode
		Open		
		Open	х	Normal Mode
		0	x	Remote Loopback
		1	0	Analog Local Loopback
		1	1	Digital Local Loopback
		impedanc signals w	ce state. There	are left open, they stay in a high fore, the layout design should not route ons near the LOOP pins. This practice w pling.
TCLK1	DI	Transmit Clock.	-	
TPOS1/	DI	Transmit Positive Data.		
TDATA1	DI	Transmit Data.		
TNEG1/	DI	Transmit Negati	ive Data.	
UBS1	DI	Unipolar/Bipola	ar Select.	
RCLK1	DO	Receive Clock.		
RPOS1/	DO	Receive Positiv	ve Data.	
RDATA1	DO	Receive Data.		
DUEQU	DO	Receive Negativ	ve Data.	
RNEG1/				
RNEG1/ BPV1	DO			
	RCLK1 RPOS1/ RDATA1 RNEG1/	RCLK1DORPOS1/DORDATA1DORNEG1/DO	RCLK1     DO     Receive Clock.       RPOS1/     DO     Receive Positiv       RDATA1     DO     Receive Data.       RNEG1/     DO     Receive Negati	RCLK1     DO     Receive Clock.       RPOS1/     DO     Receive Positive Data.       RDATA1     DO     Receive Data.       RNEG1/     DO     Receive Negative Data.

#### Table 1. Pin Assignments and Signal Descriptions (Continued)

#### Datasheet

#### Table 1. Pin Assignments and Signal Descriptions (Continued)

Ball # PBGA	Pin # LQFP	Symbol	I/O <sup>1</sup>			Description	
				TNEG are samp drivers enter a clock cycles the pulse widths are When pulse sha LXT384 device a programmable To prevent this,	bled on the ow power h pulse shap determine uping is disa by leaving e ASIC mig clock one c	ormal operation TCLK is active, and falling edge of TCLK. If TCLK is Low high Z mode. If TCLK is High for mo- bing circuit is disabled and the trans ad by the TPOS and TNEG duty cyc abled, it is possible to overheat and o transmit inputs high continuously. F ht leave all outputs high until it is pro- f these signals: TPOS, TNEG, TCLM ne of these signals low: TPOS, TNE	, the outp re than 16 mit outpu les. damage th or examp ogrammed ( or MCLk
N1	19	TCLK0	DI	TCL	.K	Operating Mode	
				Clock	ked Nor	mal operation	
				Н	TAC	DS (if MCLK supplied)	
				н		able transmit pulse shaping (when LK is not available)	
				L	Driv	ver outputs enter tri-state	
N2	20	TPOS0/ TDATA0	Transmit Positive Data.         Transmit Data.         Transmit Negative Data.         Unipolar/Bipolar Select.         DI         Bipolar Mode:         DI         TPOS/TNEG are active high NRZ inputs. TPOS ind of a positive pulse whereas TNEG indicates the tran pulse.				
				TPOS	TNEG	Selection	
				0	0	Space	
				1	0	Positive Mark	
				0	1	Negative Mark	
				1	1	Space	
N3	21	TNEG0/ UBS0	DI DI	cycles, unipolar encoding/decod	I/O is seled ling is deter	High for more than 16 consecutive cted. In unipolar mode, B8ZS/HDB3 mined by the CODEN pin (hardward CR register (software mode).	or AMI

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Ball # PBGA	Pin # LQFP	Symbol	I/O <sup>1</sup>	Description
				Receive Clock.
				Normal Mode:
		5 01 1/0		This pin provides the recovered clock from the signal received at RTIP an RRING. Under LOS conditions there is a transition from RCLK signal (derived from the recovered data) to MCLK signal at the RCLK output.
P1	22	RCLK0	DO	Data Recovery Mode:
				If MCLK is High, the clock recovery circuit is disabled and RPOS and RNEG are internally connected to an EXOR that is fed to the RCLK output for external clock recovery applications.
				RCLK will be in high impedance state if the MCLK pin is Low.
				Receive Positive.
				Receive Data.
				Receive Negative Data.
				Bipolar Violation Detect.
				Bipolar Mode:
P2 23 RPOS0/ RDATA0	DO DO	In clock recovery mode these pins act as active high bipolar non return to zero (NRZ) receive signal outputs. A High signal on RPOS corresponds to receipt of a positive pulse on RTIP/RRING. A High signal on RNEG corresponds to receipt of a negative pulse on RTIP/RRING. These signal are valid on the falling or rising edges of RCLK depending on the CLKE input.		
				In Data recovery Mode these pins act as RZ data receiver outputs. The output polarity is selectable with CLKE (Active High output polarity when CLKE is High and Active Low Polarity when CLKE is Low).
				RPOS and RNEG will go to the high impedance state when the MCLK pin is Low.
				Unipolar Mode:
P3	24	RNEG0/	DO	In uni-polar mode, the LXT386 asserts BPV High if any in-service Line Code Violation is detected. RDATA acts as the receive data output.
10	2.	BPV0	DO	Hardware Mode: During a LOS condition, RPOS and RNEG will remain active.
				Host Mode: RPOS and RNEG will either remain active or insert AIS into the receive path. Selection is determined by the RAISEN bit in the GCR register.
K4	25	LOS0	DO	<b>Loss of Signal</b> . LOS goes High to indicate a loss of signal, i.e. when the incoming signal has no transitions for a specified time interval. The LOS condition is cleared and the output pin returns to Low when the incoming signa has sufficient number of transitions in a specified time interval. See "Loss of Signal Detector" on page 24.
				Multiplexed/Non-Multiplexed Select.
K2	99	MUX	DI	When Low the parallel host interface operates in non-multiplexed mode. When High the parallel host interface operates in multiplexed mode. In hardware mode tie this unused input low.
N4, P4	26	TVCC0	s	<b>Transmit Driver Power Supply</b> . Power supply pin for the port 0 output driver. TVCC pins can be connected to either a 3.3V or 5V power supply Refer to the Transmitter description.

#### Table 1. Pin Assignments and Signal Descriptions (Continued)

Ball # PBGA	Pin # LQFP	Symbol	I/O <sup>1</sup>	Description	
				Transmit Tip.	
	07	TTIDA		Transmit Ring.	
N5	27	TTIP0	AO	These pins are differential line driver outputs. TTIP and TRING will be in	
P5	28	TRING0	AO	high impedance state if the TCLK pin is Low or the OE pin is Low. In software mode, TTIP and TRING can be tristated on a port-by-port basis by writing a '1' to the $\overline{OEx}$ bit in the Output Enable Register (OER).	
N6, P6	29	TGND0	S	Transmit Driver Ground. Ground pin for the output driver.	
		57154		Receive Tip.	
P7	30	RTIP0	AI	Receive Ring.	
N7	31	RRING0	AI	These pins are the inputs to the differential line receiver. Data and clock are recovered and output on the RPOS/RNEG and RCLK pins.	
L6, M6	32	TGND1	S	Transmit Driver Ground.	
M5	33	TRING1	AO	Transmit Ring.	
L5	34	TTIP1	AO	Transmit Tip.	
	25		s	Transmit Driver Power Supply. Power supply pin for the port 1 output driver. TVCC pins can be connected to either a 3.3V or 5V power supply	
L4, M4	35	TVCC1	5	Refer to the Transmitter description.	
L7	36	RRING1	AI	Receive Ring.	
M7	37	RTIP1	AI	Receive Tip.	
L11, M11	20	TVCC2	S	Transmit Driver Power Supply. Power supply pin for the port 2 output driver. TVCC pins can be connected to either a 3.3V or 5V power supply	
LTT, IVITT	38	10002	3	Refer to the Transmitter description.	
L10	39	TTIP2	AO	Transmit Tip.	
M10	40	TRING2	AO	Transmit Ring.	
L9, M9	41	TGND2	S	Transmit Driver Ground.	
M8	42	RTIP2	AI	Receive TIP.	
L8	43	RRING2	AI	Receive Ring.	
N9, P9	44	TGND3	S	Transmit Driver Ground.	
P10	45	TRING3	AO	Transmit Ring.	
N10	46	TTIP3	AO	Transmit Tip.	
	47			Transmit Driver Power Supply. Power supply pin for the port 3 output	
N11, P11	47	TVCC3	S	driver. TVCC pins can be connected to either a 3.3V or 5V power supply Refer to the Transmitter description.	
N8	48	RRING3	AI	Receive Ring.	
P8	49	RTIP3	AI	Receive Tip.	
K11	51	LOS3	DO	Loss of Signal.	
D40	50	RNEG3/	DO	Receive Negative Data.	
P12	52	BPV3	DO	Bipolar Violation Detect.	
D12	52	RPOS3/	DO	Receive Positive Data.	
P13	53	RDATA3	DO	Receive Data.	
P14	54	RCLK3	DO	Receive Clock.	

#### Table 1. Pin Assignments and Signal Descriptions (Continued)

2. N/C means "Not Connected"

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Pin # LQFP	Symbol	I/O <sup>1</sup>	Description
55	TNEG3/	DI	Transmit Negative Data.
55	UBS3	DI	Unipolar/Bipolar Select.
56	TPOS3/	DI	Transmit Positive Data.
00	TDATA3	DI	Transmit Data.
57	TCLK3	DI	Transmit Clock.
58	LOS2	DO	Loss of Signal.
59	RNEG2/	DO	Receive Negative Data.
	BPV2	DO	Bipolar Violation Detect.
60	RPOS2/	DO	Receive Positive Data.
	RDATA2	DO	Receive Data.
61	RCLK2	DO	Receive Clock.
62	TNEG2/	DI	Transmit Negative Data.
			Unipolar/Bipolar Select.
63			Transmit Positive Data.
			Transmit Data.
64	TCLK2	DI	Transmit Clock.
80	ĪNT	DO	<b>Interrupt.</b> This active Low, maskable, open drain output requires an external 10k pull up resistor. If the corresponding interrupt enable bit is enabled, INT goes Low to flag the host when the <i>LXT386</i> changes state (see details in the interrupt handling section). The microprocessor INT input should be set to level triggering.
			Data Transfer acknowledge (Motorola Mode).
			Ready (Intel mode).
			Serial Data Output (Serial Mode).
81	ACK/ RDY/	DO DO	Motorola Mode A Low signal during a databus read operation indicates that the information is valid. A Low signal during a write operation acknowledges that a data transfer into the addressed register has been accepted (acknowledge signal).Wait states only occur if a write cycle immediately follows a previous read or write cycle (e.g. read modify write). Intel Mode
	SDO		A High signal acknowledges that a register access operation has been completed (Ready Signal). A Low signal on this pin signals that a data transfer operation is in progress. The pin goes tristate after completion of a bus cycle. <u>Serial Mode</u> If CLKE is High, SDO is valid on the rising edge of SCLK. If CLKE is Lo SDO is valid on the falling edge of SCLK. This pin goes into high Z state during a serial port write access.
	LQFP 55 56 57 58 59 60 61 62 63 64 80	LQFP         Symbol           55         TNEG3/ UBS3           56         TPOS3/ TDATA3           57         TCLK3           58         LOS2           59         RNEG2/ BPV2           60         RPOS2/ RDATA2           61         RCLK2           62         TNEG2/ UBS2           63         TPOS2/ TDATA2           64         TCLK2           80         ĪNT           80         ĀCK/ RDY/           81         ÄCK/	LQFP         Symbol         J/O'           55         TNEG3/ UBS3         DI UBS3         DI DI           56         TPOS3/ TDATA3         DI           57         TCLK3         DI           58         LOS2         DO           59         RNEG2/ BPV2         DO           60         RPOS2/ RDATA2         DO           61         RCLK2         DO           62         TNEG2/ UBS2         DI           63         TPOS2/ TDATA2         DI           64         TCLK2         DI           64         TOLK2         DI           80         INT         DO           80         INT         DO           80         RPK         DO           81         RDY/         DO

#### Table 1. Pin Assignments and Signal Descriptions (Continued)

PBGA	Pin # LQFP	Symbol	I/O <sup>1</sup>	Description
J14	3	DS/ WR/ SDI/ LEN0	DI DI DI DI	Data Strobe (Motorola Mode).         Write Enable (Intel mode).         Serial Data Input (Serial Mode).         Line Length Equalizer (Hardware Mode). <u>Host Mode</u> This pin acts as data strobe in Motorola mode and as Write Enable in Intel mode. In serial mode this pin is used as Serial Data Input. <u>Hardware Mode</u> This pin determines the shape and amplitude of the transmit pulse. Refer to Table 2.
J13	2	R / Ŵ/ RD/ LEN1	DI DI DI	Read/Write (Motorola Mode).         Read Enable (Intel mode).         Line Length Equalizer (Hardware Mode). <u>Host Mode</u> This pin functions as the read/write signal in Motorola mode and as the Read Enable in Intel mode. <u>Hardware Mode</u> This pin determines the shape and amplitude of the transmit pulse. Refer to Table 2.
J12       82       ALE/       DI       Address Strobe (Motorola Mode).         J12       82       ALE/       DI       Host Mode         J12       82       SCLK/       DI       Host Mode         J12       82       SCLK/       DI       Host Mode         J12       82       SCLK/       DI       Host Mode         J12       B1       SCLK/       DI       Host Mode         J12       B2       JI       In serial Host mode       Host Mode         J12       B2       JI       In serial Host mode this pin acts as serial shift clock.       In Motorola mode this pin acts a an active Low address strobe.         Hardware Mode       This pin determines the shape and amplitude of the transmit pulse. Refer       To able 2.				

#### Table 1. Pin Assignments and Signal Descriptions (Continued)



Ball # PBGA	Pin # LQFP	Symbol	I/O <sup>1</sup>	Description	
J11	98	ĊS/ JASEL	DI DI	Chip Select/Jitter Attenuator Select.         Host Mode         This active Low input is used to access the serial/parallel interface. For each read or write operation, $\overline{CS}$ must transition from High to Low, and remain Low.         Hardware Mode         This input determines the Jitter Attenuator position in the data path:         JASEL       JA Position         L       Transmit path       H       Receive path       Z       Disabled	
H12	1	MOT/INTL/ CODEN	DI DI	Motorola/Intel/Codec Enable Select.           Host Mode:           When Low, the host interface is configured for Motorola microcontrollers.           When High, the host interface is configured for Intel microcontrollers.           Hardware Mode:           This pin determines the line encode/decode selection when in unipolar mode:           When Low, B8ZS/HDB3 encoders/decoders are enabled for T1/E1 respectively. When High, enables AMI encoder/decoder (transparent mode).	
G13	76	AT2	AO	JTAG Analog Output Test Port 2.	
H13	77	AT1	AI	JTAG Analog Input Test Port 1.	
G12	72	TRST		<b>JTAG Controller Reset.</b> Input is used to reset the JTAG controller. TRST is pulled up internally and may be left disconnected.	
F11	71	TMS	DI	<b>JTAG Test Mode Select.</b> Used to control the test logic state machine. Sampled on rising edge of TCK. TMS is pulled up internally and may be left disconnected.	
F14	69	ТСК	DI	JTAG Clock. Clock input for JTAG. Connect to GND when not used.	
F13	73	TDO	DO	<b>JTAG Data Output.</b> Test Data Output for JTAG. Used for reading all serial configuration and test data from internal test logic. Updated on falling edge of TCK.	
F12	70	TDI	DI	<b>JTAG Data Input</b> . Test Data input for JTAG. Used for loading serial instructions and data into internal test logic. Sampled on rising edge of TCK. TDI is pulled up internally and may be left disconnected.	
E14	83	OE	DI	<b>Output Driver Enable.</b> If this pin is asserted Low all analog driver outputs immediately enter a high impedance mode to support redundancy applications without external mechanical relays. All other internal circuitry stays active. In software mode, TTIP and TRING can be tristated on a port-by-port basis by writing a '1' to the OEx bit in the Output Enable Register (OER).	
N.C.: Not	Input; DO: D Connected. ns "Not Conne		O: Digital		

#### Table 1. Pin Assignments and Signal Descriptions (Continued)

Table 1.	Pin Assignments and Signal Descriptions (Continued)	

Ball # PBGA	Pin # LQFP	Symbol	I/O <sup>1</sup>	Description			
E13	E13 84 CLKE		DI	<b>Clock Edge Select.</b> In clock recovery mode, setting CLKE High causes RDATA or RPOS and RNEG to be valid on the falling edge of RCLK and SDO to be valid on the rising edge of SCLK. Setting CLKE Low makes RDATA or RPOS and RNEG to be valid on the rising edge of RCLK and SDO to be valid on the falling edge of SCLK. In Data recovery Mode, RDATA or RPOS/RNEG are active High output polarity when CLKE is High and active low polarity when CLKE is Low.			
210	01	OLIXE		CLKE RPOS/RNEG SDO			
				Low RCLK SCLK			
				High RCLK SCLK			
N/C <sup>2</sup>	100	RESET	DI	Reset Input. (Added in Revision B1) In either hardware mode or software mode, setting RESET low will begin to initialize the LXT386 and freeze the device until set high. One microsecond after setting RESET high, initialization will complete and the LXT386 will be ready for normal operation. For Revision B1 only, the device requires a pull up resistor to VCC at this pin between 1 and 10 kohms in value. It is not necessary to retain the pull up resistor for any other revision. Please refer to the section on Reset Operation for more information. The BGA package does not have this pin feature.			
A6, A9 B: 1, 2, 3, 6, 9, 12, 13, 14 C6, C9 D: 1, 2, 3, 6, 9, 12, 13, 14 G4, G11 H4, H11	5, 7, 10, 11, 65, 66, 74	GND	S <b>Power Supply Ground.</b> Connect all pins to power supply ground.				
1. DI: Digital N.C.: Not ( 2. N/C means	Connected.		D: Digital	Bidirectional Port; AI: Analog Input; AO: Analog Output S: Power Supply;			



Ball # PBGA	Pin # LQFP	Symbol	I/O <sup>1</sup>	Description		
A4, B4, C4, C11, D4, D11, G1, G14, H1, H14	4, 6, 8, 9, 67, 68, 75,	VCC	S	Power Supply. Connect all pins to +3.3 volt power supply.		
A11, B11	-	TVCC	S	<b>Transmit Driver Power Supply</b> . Power supply pins for the output drivers. TVCC pins can be connected to either a 3.3V or 5V power supply. Refer to "Transmitter" on page 25 for details.		
A: 1, 2, 3, 5,       7, 10, 12,         13, 14       B: 7, 8, 10         C: 1, 2, 3, 5,       50         7, 8, 10, 12,       13, 14         D: 5, 7, 8, 10       E: 3, 4, 11,         12       NC						
N.C.: Not 0	<ol> <li>DI: Digital Input; DO: Digital Output; DI/O: Digital Bidirectional Port; AI: Analog Input; AO: Analog Output S: Power Supply; N.C.: Not Connected.</li> <li>N/C means "Not Connected"</li> </ol>					

	Table 1.	Pin Assig	nments	and Sig	gnal Descri	ptions	(Continued)	)
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# 3.0 Functional Description

Figure 1 is a simplified block diagram of the LXT386. The LXT386 is a fully integrated quad line interface unit designed for T1 1.544 Mbps and E1 2.048 Mbps short haul applications.

Each transceiver front end interfaces with four lines, one pair for transmit, one pair for receive. These two lines comprise a digital data loop for full duplex transmission.

The LXT386 can be controlled through hard-wired pins or by a microprocessor through a serial or parallel interface (Host mode).

The transmitter timing reference is TCLK, and the receiver reference clock is MCLK. The LXT386 is designed to operate without any reference clock when used as an analog front-end (line driver and data recovery). MCLK is mandatory if the on chip clock recovery capability is used. All four clock recovery circuits share the same reference clock defined by the MCLK input signal.

### 3.1 Initialization

During power up, the transceiver remains static until the power supply reaches approximately 60% of VCC. During power-up, an internal reset sets all registers to their default values and resets the status and state machines for the LOS.

#### 3.1.1 Reset Operation

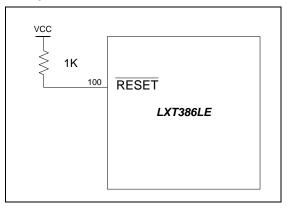
In Revision B1, no connect pin 100 was converted to the  $\overline{\text{RESET}}$  pin. Only revision B1 requires a pull up resistor to VCC at pin 100, the pull up resistor is unnecessary for all other revisions. Figure 4 shows the connections needed for revision B1 only. Note: The BGA package does not have a  $\overline{\text{RESET}}$  pin.

There are two methods of resetting the LXT386:

- 1. Override Reset Setting the RESET pin low in either hardware mode or host mode. Until the RESET pin returns high, the LXT386 remains frozen and will not function. Once the RESET pin has returned high, the LXT386 will operaate normally. Override Reset changes all the internal registers to their default values.
- 2. Software Reset Writing to the RES reset register initiates a 1microsecond reset cycle, except in Intel non-multiplexed mode. In Intel non-multiplexed mode, the reset cycle takes 2 microseconds. Please refer to Host mode section for more information. This operation changes all LXT386 registers to their default values.



Figure 5. Pullup Resistor to RESET



## 3.2 Receiver

The four receivers in the LXT386 are identical. The following paragraphs describe the operation of one.

The twisted-pair input is received via a 1:2 step down transformer. Positive pulses are received at RTIP, negative pulses at RRING. Recovered data is output at RPOS and RNEG in the bipolar mode and at RDATA in the unipolar mode. The recovered clock is output at RCLK. RPOS/RNEG validation relative to RCLK is pin selectable (CLKE).

The receive signal is processed through the peak detector and data slicers. The peak detector samples the received signal and determines its maximum value. A percentage of the peak value is provided to the data slicers as a threshold level to ensure optimum signal-to-noise ratio. For DSX-1 applications (line length inputs LEN2-0 from 011 to 111) the threshold is set to 70% (typical) of the peak value. This threshold is maintained above the specified level for up to 15 successive zeros over the range of specified operating conditions. For E1 applications (LEN2-0 = 000), the threshold is 50% (typical).

The receiver is capable of accurately recovering signals with up to 12 dB of attenuation (from 2.4 V), corresponding to a received signal level of approximately 500 mV. Maximum line length is 1500 feet of ABAM cable (approximately 6 dB of attenuation). Regardless of received signal level, the peak detectors are held above a minimum level of 0.150 V (typical) to provide immunity from impulsive noise.

After processing through the data slicers, the received signal goes to the data and timing recovery section. The data and timing recovery circuits provide an input jitter tolerance better than required by Pub 62411 and ITU G.823, as shown in Test Specifications, Figure 33.

Depending on the options selected, recovered clock and data signals may be routed through the jitter attenuator, through the B8ZS/HDB3/AMI decoder, and may be output to the framer as either bipolar or unipolar data.



#### 3.2.1 Loss of Signal Detector

The loss of signal detector in the LXT386 uses a dedicated analog and digital loss of signal detection circuit. It is independent of its internal data slicer comparators and complies to the latest ITU G.775 and ANSI T1.231 recommendations. Under software control, the detector can be configured to comply to the ETSI ETS 300 233 specification (LACS Register). In hardware mode, the LXT386 supports LOS per G.775 for E1 and ANSI T1.231 for T1 operation.

The receiver monitor loads a digital counter at the RCLK frequency. The counter is incremented each time a zero is received, and reset to zero each time a one (mark) is received. Depending on the operation mode, a certain number of consecutive zeros sets the LOS signal. The recovered clock is replaced by MCLK at the RCLK output with a minimum amount of phase errors. MCLK is required for receive operation. When the LOS condition is cleared, the LOS flag is reset and another transition replaces MCLK with the recovered clock at RCLK. RPOS/RNEG will reflect the data content at the receiver input during the entire LOS detection period for that channel.

#### 3.2.1.1 E1 Mode

In G.775 mode a loss of signal is detected if the signal is below 200mV (typical) for 32 consecutive pulse intervals. When the received signal reaches 12.5% ones density (4 marks in a sliding 32-bit period) with no more than 15 consecutive zeros and the signal level exceeds 250mV (typical), the LOS flag is reset and another transition replaces MCLK with the recovered clock at RCLK.

In ETSI 300 233 mode, a loss of signal is detected if the signal is below 200mV for 2048 consecutive intervals (1 ms). The LOS condition is cleared and the output pin returns to Low when the incoming signal has transitions when the signal level is equal or greater than 250mV for more than 32 consecutive pulse intervals. This mode is activated by setting the LACS register bit to one. If it is necessary to use AIS with LOS, see errata 10.3 for a way to implement this.

#### 3.2.1.2 T1 Mode

The T1.231 LOS detection criteria is employed. LOS is detected if the signal is below 200mV for 175 contiguous pulse positions. The LOS condition is terminated upon detecting an average pulse density of 12.5% over a period of 175 contiguous pulse positions starting with the receipt of a pulse. The incoming signal is considered to have transitions when the signal level is equal or greater than 250mV.

#### 3.2.1.3 Data Recovery Mode

In data recovery mode the LOS digital timing is derived from a internal self timed circuit. RPOS/ RNEG stay active during loss of signal. The analog LOS detector complies with ITU-G.775 recommendation. The LXT386 monitors the incoming signal amplitude. Any signal below 200mV for more than  $30\mu s$  (typical) will assert the corresponding LOS pin. The LOS condition is cleared when the signal amplitude rises above 250mV. The LXT386 requires more than 10 and less than 255 bit periods to declare a LOS condition in accordance to ITU G.775.

#### 3.2.2 Alarm Indication Signal (AIS) Detection

The AIS detection is performed by the receiver independent of any loopback mode. This feature is available in host mode only. Because there is no clock in data recovery mode, AIS detection will not work in that mode. AIS requires MCLK to have clock applied, since this function depends on the clock to count the number of ones in an interval.



#### 3.2.2.1 E1 Mode

One detection mode suitable for both ETSI and ITU is available when the LACS register bits are cleared to zero. If the LACS register bit is set to one, see errata 10.3 to implement this:

#### ETSI ETS300233 and G.775 detection

The AIS condition is declared when the received data stream contains less than 3 zeros within a period of 512 bits.

The AIS condition is cleared when 3 or more zeros within 512 bits are detected.

#### 3.2.2.2 T1 Mode

ANSI T1.231 detection is employed.

The AIS condition is declared when less than 9 zeros are detected in any string of 8192 bits. This corresponds to a 99.9% ones density over a period of 5.3ms.

The AIS condition is cleared when the received signal contains 9 or more zeros in any string of 8192 bits.

#### 3.2.3 In Service Code Violation Monitoring

In unipolar I/O mode with HDB3/B8ZS decoding, the LXT386 reports bipolar violations on RNEG/BPV for one RCLK period for every HDB3/B8ZS code violation that is not part of the zero code substitution rules. In AMI mode, all bipolar violations (two consecutive pulses with the same polarity) are reported at the BPV output.

#### 3.3 Transmitter

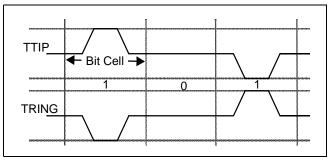
The four low power transmitters of the LXT386 are identical.

Transmit data is clocked serially into the device at TPOS/TNEG in the bipolar mode or at TDATA in the unipolar mode. The transmit clock (TCLK) supplies the input synchronization. Unipolar I/O and HDB3/B8ZS/AMI encoding/decoding is selected by pulling TNEG High for more than 16 consecutive TCLK clock cycles. The transmitter samples TPOS/TNEG or TDATA inputs on the falling edge of TCLK. Refer to the Test Specifications Section for MCLK and TCLK timing characteristics. If TCLK is not supplied, the transmitter remains powered down and the TTIP/TRING outputs are held in a High Z state. In addition, fast output tristatability is also available through the OE pin (all ports) and/or the port's OEx bit in the Output Enable Register (OER).

Zero suppression is available only in Unipolar Mode. The two zero-suppression types are B8ZS, used in T1 environments, and HDB3, used in E1 environments. The scheme selected depends on whether the device is set for T1 or E1 operation (determined by LEN2-0 pulse shaping settings). The LXT386 also supports AMI line coding/decoding as shown in Figure 6. In Hardware mode, AMI coding/decoding is selected by the CODEN pin. In host mode, AMI coding/decoding is selected by bit 4 in the GCR (Global Control Register).

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#### Figure 6. 50% AMI Encoding



Each output driver is supplied by a separate power supply (TVCC and TGND). The transmit pulse shaper is bypassed if no MCLK is supplied while TCLK is pulled high. In this case TPOS and TNEG control the pulse width and polarity on TTIP and TRING. With MCLK supplied and TCLK pulled high the driver enters TAOS (Transmit All Ones pattern). Note that the TAOS generator uses MCLK as a timing reference. In order to assure that the output frequency is within specification limits, MCLK must have the applicable stability.TAOS is inhibited during Remote Loopback.

#### 3.3.1 Transmit Pulse Shaping

The transmitted pulse shape is internally generated using a high speed D/A converter. Shaped pulses are further applied to the line driver for transmission onto the line at TTIP and TRING. The line driver provides a constant low output impedance regardless of whether it is driving marks, spaces or if it is in transition. This well controlled dynamic impedance provides excellent return loss when used with external precision resistors ( $\pm$  1% accuracy) in series with the transformer.

#### 3.3.1.1 Hardware Mode

In hardware mode, pins LEN0-2 determine the pulse shaping as described in Table 2. The LEN settings also determine whether the operating mode is T1 or E1. Note that in T1 operation mode, all four ports will share the same pulse shaping setting. Independent pulse shaping for each channel is available in host mode

#### 3.3.1.2 Host Mode

In Host Mode, the contents of the Pulse Shaping Data Register (PSDAT) determines the shape of pulse output at TTIP/TRING. Refer to Table 24 and Table 25.



LEN2	LEN1	LEN0	Line Length <sup>1</sup>	Cable Loss <sup>2</sup>	<b>Operation Mode</b>
0	1	1	0 - 133 ft. ABAM	0.6 dB	
1	0	0	133 - 266 ft. ABAM	1.2 dB	
1	0	1	266 - 399 ft. ABAM	1.8 dB	
1	1	0	399 - 533 ft. ABAM	2.4 dB	T1
1	1	1	533 - 655 ft. ABAM	3.0 dB	
0 0 0 E1 G.703, 75Ω coaxial cable and 120 Ω twisted pair cable. E1					
1. Line length from LXT386 to DSX-1 cross-connect point. 2. Maximum cable loss at 772KHz.					

#### Table 2. Line Length Equalizer Inputs

3.3.2 Transmit Pulse Shaping

The transmitted pulse shape is internally generated using a high speed D/A converter. Shaped pulses are further applied to the line driver for transmission onto the line at TTIP and TRING. The line driver provides a constant low output impedance regardless of whether it is driving marks.

#### 3.3.2.1 Output Driver Power Supply

The output driver power supply (TVCC pins) can be either 3.3V or 5V nominal. When TVCC=5V, LXT386 drives both E1 (75 $\Omega$ /120 $\Omega$ ) and T1 100 $\Omega$  lines through a 1:2 transformer and 11 $\Omega$ /9.1 $\Omega$  series resistors.

When TVCC=3.3V, the LXT386 drives E1 (75 $\Omega$ /120 $\Omega$ ) lines through a 1:2 transformer and 11 $\Omega$  series resistor. A configuration with a 1:2 transformer and without series resistors should be used to drive T1 100 $\Omega$  lines.

Removing the series resistors for T1 applications with TVCC=3.3V, improves the power consumption of the device. See Table 35.

On the other hand, series resistors in the transmit configuration improve the transmit return loss performance. Good transmit return loss performance minimizes reflections in harsh cable environments. In addition, series resistors provide protection against surges coupled to the device. The resistors should be used in systems requiring protection switching without external relays. Please refer to Figure 7 for the recommended external line circuitry.

#### 3.3.2.2 Power Sequencing

For the LXT384, we recommend sequencing TVCC first then VCC second or at the same time as TVCC to prevent excessive current draw.

### 3.4 Driver Failure Monitor

The LXT386 transceiver incorporates an internal power Driver Failure Monitor (DFM) in parallel with TTIP and TRING that is capable of detecting secondary shorts without cable. DFM is available only in configurations with no transmit series resistors (T1 mode with TVCC=3.3V). This feature is available in the serial and parallel host modes but not available in the hardware mode of operation.



A capacitor, charged via a measure of the driver output current and discharged by a measure of the maximum allowable current, is used to detect a secondary short failure. Secondary shorted lines draw excess current, overcharging the cap. When the capacitor charge deviates outside the nominal charge window, a driver short circuit fail (DFM) is reported in the respective register by setting an interrupt. During a long string of spaces, a short-induced overcharge eventually bleeds off, clearing the DFM flag.

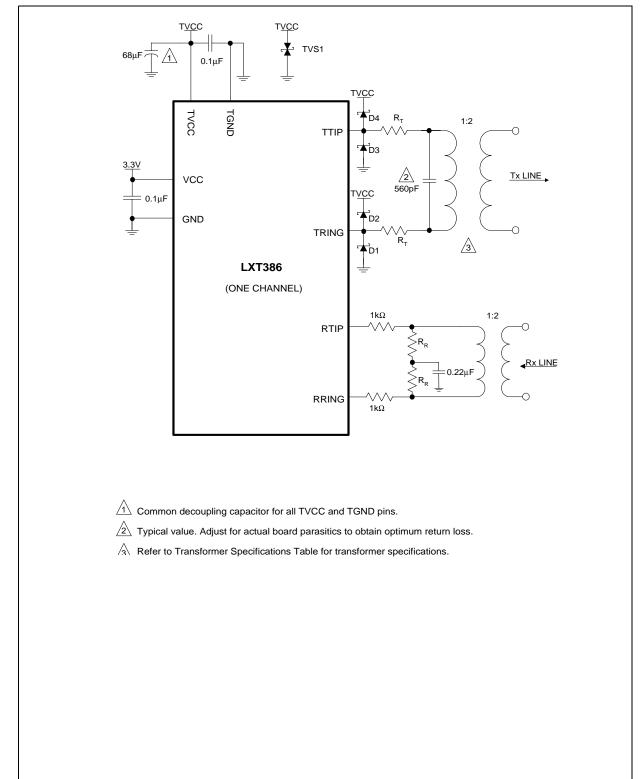
Note that unterminated lines of adequate length ( $\lambda/4$ ) may effectively behave as short-circuits as seen by the driver and therefore trigger the DFM. Under these circumstances, the alarm should be disabled.

In addition, LXT386 features output driver short-circuit protection. When the output current exceeds 100 mA, LXT386 limits the driver's output voltage to avoid damage.

### 3.5 Line Protection

Figure 7 on page 29 shows recommended line interface circuitry. In the receive side, the 1 k $\Omega$  series resistors protect the receiver against current surges coupled into the device. Due to the high receiver impedance (70 k $\Omega$  typical) the resistors do not affect the receiver sensitivity. In the transmit side, the Schottky diodes D1-D4 protect the output driver. While not mandatory for normal operation, these protection elements are strongly recommended to improve the design robustness.

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#### Figure 7. External Transmit/Receive Line Circuitry

### **3.6 Jitter Attenuation**

A digital Jitter Attenuation Loop (JAL) combined with a FIFO provides Jitter attenuation. The JAL is internal and requires no external crystal nor high-frequency (higher than line rate) reference clock.

In Host Mode, the Global Control Register (GCR) determines whether the JAL is positioned in the receive or transmit path. In Hardware Mode, the JAL position is determined by the JASEL pin.

The FIFO is a 32 x 2-bit or 64 x 2-bit register (selected by the FIFO64 bit in the GCR). Data is clocked into the FIFO with the associated clock signal (TCLK or RCLK), and clocked out of the FIFO with the dejittered JAL clock. See Figure 8. When the FIFO is within two bits of overflowing or underflowing, the FIFO adjusts the output clock by 1/8 of a bit period. The Jitter Attenuator produces a constant delay of 17 or 33 bits in the associated path (refer to test specifications). This feature can be used for hitless switching applications. This advanced digital jitter attenuator meets latest jitter attenuation specifications. See Table 3.

Under software control, the low limit jitter attenuator corner frequency depends on FIFO length and the JACF bit setting (this bit is in the GCR register). In Hardware Mode, the FIFO length is fixed to 64 bits. The corner frequency is fixed to 6 Hz for T1 mode and 3.5 Hz for E1 mode.

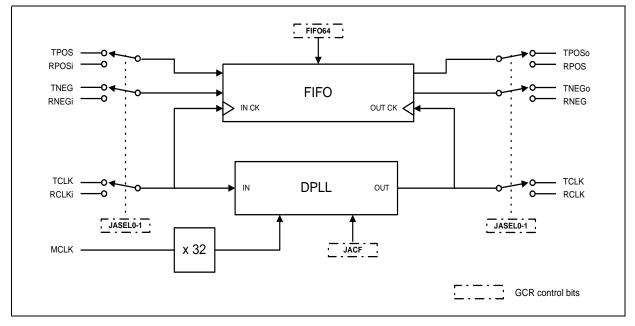
#### Table 3. Jitter Attenuation Specifications

Т1	E1					
AT&T Pub 62411	ITU-T G.736					
GR-253-CORE <sup>1</sup>	ITU-T G.742 <sup>3</sup>					
ITU-T G.783 <sup>4</sup>						
TR-TSY-000009 <sup>2</sup>	ETSI CTR12/13					
BAPT 220						
<ol> <li>Category I, R5-203.</li> <li>Section 4.6.3.</li> <li>Section 6.2 When used with the SXT6234 E2-E1 m</li> </ol>						

4. Section 6.2.3.3 combined jitter when used with the SXT6251 21E1 mapper.

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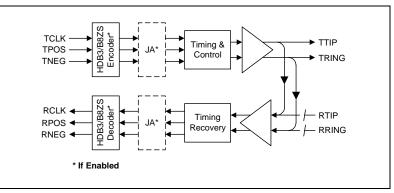
## 3.7 Loopbacks

The LXT386 offers three loopback modes for diagnostic purposes. In hardware mode, the loopback mode is selected with the LOOPn pins. In software mode, the ALOOP, DLOOP and RLOOP registers are employed.

#### 3.7.1 Analog Loopback

When selected, the transmitter outputs (TTIP & TRING) are connected internally to the receiver inputs (RTIP & RRING) as shown in Figure 9. Data and clock are output at RCLK, RPOS & RNEG pins for the corresponding transceiver. Note that signals on the RTIP & RRING pins are ignored during analog loopback.

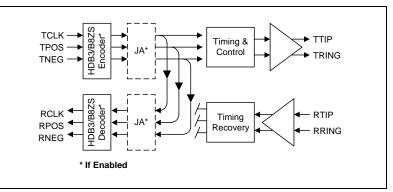




#### 3.7.2 Digital Loopback

The digital loopback function is available in software and hardware mode. When selected, the transmit clock and data inputs (TCLK, TPOS & TNEG) are looped back and output on the RCLK, RPOS & RNEG pins (Figure 10). The data presented on TCLK, TPOS & TNEG is also output on the TTIP & TRING pins. Note that signals on the RTIP & RRING pins are ignored during digital loopback.

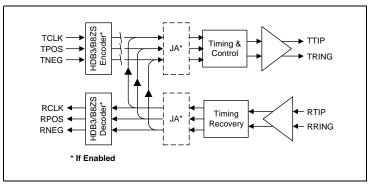
#### Figure 10. Digital Loopback

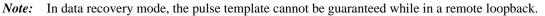


#### 3.7.3 Remote Loopback

During remote loopback (Figure 11) the RCLK, RPOS & RNEG outputs routed to the transmit circuits and output on the TTIP & TRING pins. Note that input signals on the TCLK, TPOS & TNEG pins are ignored during remote loopback.

#### Figure 11. Remote Loopback





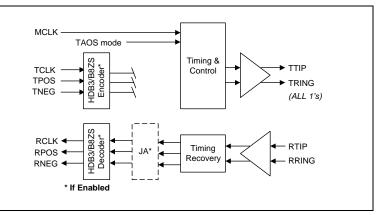
#### 3.7.4 Transmit All Ones (TAOS)

In Hardware mode, the TAOS mode is set by pulling TCLK High for more than 16 MCLK cycles. In software mode, TAOS mode is set by asserting the corresponding bit in the TAOS Register. In addition, automatic ATS insertion (in case of LOS) may be set using the ATS Register.

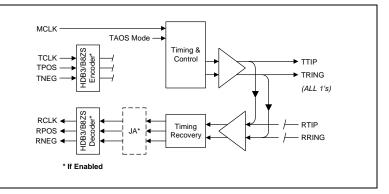
Note: The TAOS generator uses MCLK as a timing reference, therefore TAOS doesn't work in data recovery mode. In order to assure that the output frequency is within specification limits, MCLK must have the applicable stability. DLOOP does not function with TAOS active.



#### Figure 12. TAOS Data Path



#### Figure 13. TAOS with Analog Loopback



## 3.8 G.772 Performance Monitoring

The LXT386 can be configured as a quad line interface unit with all channels working as regular transceivers. In applications using only three channels, the fourth channel can be configured to monitor any of the remaining channels inputs or outputs. The monitoring is non-intrusive per ITU-T G.772. Figure 2 on page 8 illustrates this concept.

The monitored line signal (input or output) goes through channel 0 clock and data recovery. The signal can be observed digitally at the RCLK/RPOS/RNEG outputs. This feature can also be used to create timing interfaces derived from an E1 or T1 signal.

In addition, channel 0 can be configured to a Remote Loopback while in monitoring mode (TCLK0 must be active in order for this operation to take place). This will output the same data as in the signal being monitored at the channel 0 output (TTIP/TRING). The output signal can then be connected to a standard test equipment with a T1/E1 electrical interface for monitoring purposes (non-intrusive monitoring).

### 3.9 Hitless Protection Switching (HPS)

The LXT386 transceivers include an output driver tristatability feature for T1/E1 redundancy applications. This feature greatly reduces the cost of implementing redundancy protection by eliminating external relays. Please refer to Application Note 119 for guidelines for implementing redundancy systems for both T1 and E1 operation using the LXT380/1/4/6.

### 3.10 Operation Mode Summary

Table 4 lists summarizes all LXT386 hardware settings and corresponding operating modes.

MCLK	TCLK	LOOP <sup>1</sup>	Receive Mode	Transmit Mode	Loopback
Clocked	Clocked	Open	Data/Clock recovery	Pulse Shaping ON	No Loopback
Clocked	Clocked	L	Data/Clock recovery	Pulse Shaping ON	Remote Loopback
Clocked	Clocked	Н	Data/Clock recovery	Pulse Shaping ON	Analog Loopback
Clocked	L	Open	Data/Clock recovery	Power down	No Loopback
Clocked	L	L	Data/Clock Recovery	Power down	No effect on op.
Clocked	L	Н	Data/Clock Recovery	Power down	No Analog Loopback
Clocked	н	Open	Data/Clock Recovery	Transmit All Ones	No Loopback
Clocked	н	L	Data/Clock Recovery	Pulse Shaping ON	Remote Loopback
Clocked	н	Н	Data/Clock Recovery	Transmit All Ones	No effect on op.
L	Clocked	Open	Power Down	Pulse Shaping ON	No Loopback
L	Clocked	L	Power Down	Pulse Shaping ON	No Remote Loopback
L	Clocked	Н	Power Down	Pulse Shaping ON	No effect on op.
L	н	Open	Power Down	Pulse Shaping OFF	No Loopback
L	н	L	Power Down	Pulse Shaping OFF	No Remote Loop
L	н	Н	Power Down	Pulse Shaping OFF	No effect on op.
L	L	Х	Power Down	Power down	No Loopback
Н	Clocked	Open	Data Recovery	Pulse Shaping ON	No Loopback
Н	Clocked	L	Data Recovery	Pulse Shaping OFF	Remote Loopback
Н	Clocked	Н	Data Recovery	Pulse Shaping ON	Analog Loopback
Н	L	Open	Data Recovery	Power down	No Loopback
Н	L	L	Data Recovery	Pulse Shaping OFF	Remote Loopback
Н	Н	Open	Data Recovery	Pulse Shaping OFF	No Loopback
Н	Н	L	Data Recovery	Pulse Shaping OFF	Remote Loopback
Н	Н	Н	Data Recovery	Pulse Shaping OFF	Analog Loopback
1. Hardware n	node only.			1	1

#### Table 4. Operation Mode Summary

## 3.11 Interfacing with 5V logic

The LXT386 can interface directly with 5V logic. The internal input pads are tolerant to 5V outputs from TTL and CMOS family devices.

### 3.12 Parallel Host Interface

The LXT386 incorporates a highly flexible 8-bit parallel microprocessor interface. The interface is generic and is designed to support both non-multiplexed and multiplexed address/data bus systems for Motorola and Intel bus topologies. Two pins (MUX and MOT/INTL) select four different operating modes as shown in Table 5.

#### Table 5. Microprocessor Parallel Interface Selection

MUX	MOT/INTL	Operating Mode
Low	Low	Motorola Non-Multiplexed
Low	High	Intel Non-Multiplexed
High	Low	Motorola Multiplexed
High	High	Intel Multiplexed

The interface includes an address bus (A4 - A0) and a data bus (D7 - D0) for non-multiplexed operation and an 8-bit address/data bus for multiplexed operation. WR, RD, R/W, CS, ALE, DS, INT and RDY/ACK are used as control signals. A significant enhancement is an internal wait-state generator that controls an Intel and Motorola compatible handshake output signal (RDY/ACK). In Motorola mode ACK Low signals valid information is on the data bus. During a write cycle a Low signal acknowledges the acceptance of the write data.

In Intel mode RDY High signals to the controlling processor that the bus cycle can be completed. While Low the microprocessor must insert wait states. This allows the LXT386 to interface with wait-state capable micro controllers, independent of the processor bus speed. To activate this function a reference clock is required on the MCLK pin.

There is one exception to write cycle timing for Intel non-multiplexed mode: Register 0Ah, the reset register. Because of timing issues, the RDY line remains high after the first part of the cycle is done, not signalling write cycle completion with another transition low. In this mode, add 2 microseconds of delay, overall 3 microseconds from CS low to end of cycle, to allow the reset cycle to completely initialize the device before proceeding.

An additional active Low interrupt output signal indicates alarm conditions like LOS and DFM to the microprocessor.

The LXT386 has a 5 bit address bus and provides 18 user accessible 8-bit registers for configuration, alarm monitoring and control of the chip.

#### 3.12.1 Motorola Interface

The Motorola interface is selected by asserting the  $\overline{\text{MOT}}/\text{INTL}$  pin Low. In non-multiplexed mode the falling edge of  $\overline{\text{DS}}$  is used to latch the address information on the address bus. In multiplexed operation the address on the multiplexed address data bus is latched into the device with the falling edge of  $\overline{\text{AS}}$ . In non-multiplexed mode,  $\overline{\text{AS}}$  should be pulled High.



The  $R/\overline{W}$  signal indicates the direction of the data transfer. The  $\overline{DS}$  signal is the timing reference for all data transfers and typically has a duty cycle of 50%. A read cycle is indicated by asserting  $R/\overline{W}$  High with a falling edge on  $\overline{DS}$ . A write cycle is indicated by asserting  $R/\overline{W}$  Low with a rising edge on  $\overline{DS}$ .

Both cycles require the  $\overline{CS}$  signal to be Low and the Address pins to be actively driven by the microprocessor. Note that  $\overline{CS}$  and  $\overline{DS}$  can be connected together in Motorola mode. In a write cycle the data bus is driven by the microprocessor. In a read cycle the bus is driven by the LXT386.

#### 3.12.2 Intel Interface

The Intel interface is selected by asserting the  $\overline{\text{MOT}}$ /INTL pin High. The LXT386 supports nonmultiplexed interfaces with separate address and data pins when MUX is asserted Low, and multiplexed interfaces when MUX is asserted High. The address is latched in on the falling edge of ALE. In non-multiplexed mode, ALE should be pulled High. R/W is used as the RD signal and DS is used as the WR signal. A read cycle is indicated to the LXT386 when the processor asserts RD Low while the WR signal is held High. A write operation is indicated to the LXT386 by asserting WR Low while the RD signal is held High. Both cycles require the CS signal to be Low.

### 3.13 Interrupt Handling

#### **Interrupt Sources**

There are three interrupt sources:

- 1. Status change in the Loss Of Signal (LOS) status register (04H). The LXT386's analog/digital loss of signal processor continuously monitors the receiver signal and updates the specific LOS status bit to indicate presence or absence of a LOS condition.
- 2. Status change in the Driver Failure Monitoring (DFM) status register (05H). The LXT386's smart power driver circuit continuously monitors the output drivers signal and updates the specific DFM status bit to indicate presence or absence of a secondary driver short circuit condition.
- 3. Status change in the Alarm Indication Signal (AIS) status register (13H). The LXT386's receiver monitors the incoming data stream and updates the specific AIS status bit to indicate presence or absence of a AIS condition.

#### 3.13.1 Interrupt Enable

The LXT386 provides a latched interrupt output ( $\overline{INT}$ ). An interrupt occurs any time there is a transition on any enabled bit in the status register. Registers 06H, 07H and 14H are the LOS, DFM and AIS interrupt enable registers (respectively). Writing a logic "1" into the mask register will enable the respective bit in the respective Interrupt status register to generate an interrupt. The power-on default value is all zeroes. The setting of the interrupt enable bit does not affect the operation of the status registers.

Registers 08H, 09H and 15H are the LOS, DFM and AIS (respectively) interrupt status registers. When there is a transition on any enabled bit in a status register, the associated bit of the interrupt status register is set and an interrupt is generated (if one is not already pending). When an interrupt



occurs, the INT pin is asserted Low. The output stage of the INT pin consists only of a pull-down device; an external pull-up resistor of approximately 10k ohm is required to support wired-OR operation.

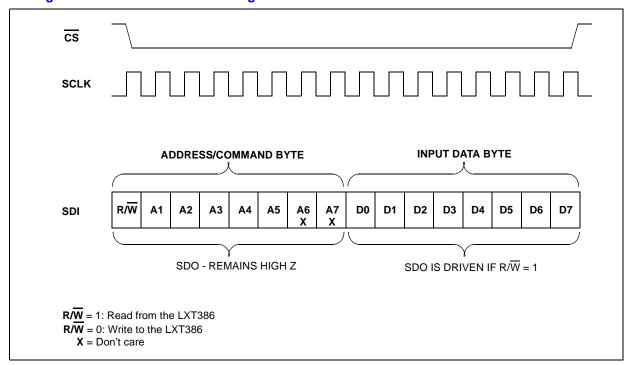
#### 3.13.2 Interrupt Clear

When an interrupt occurs, the interrupt service routine (ISR) should read the *interrupt status registers* (08H, 09H and 15H) to identify the interrupt source. Reading the Interrupt Status register clears the "sticky" bit set by the interrupt. Automatically clearing the register prepares it for the next interrupt.

The ISR should then read the corresponding *status monitor register* to obtain the current status of the device. Note that there are three status monitor registers: the LOS (04H), the DFM (05H) and the AIS (013H). Reading either status monitors register will clear its corresponding interrupts on the rising edge of the read or data strobe. When all pending interrupts are cleared, the INT pin goes High.

### 3.14 Serial Host Mode

The LXT386 operates in Serial Host Mode when the MODE pin is tied to VCC÷2. Figure 14 shows the SIO data structure. The registers are accessible through a 16 bit word: an 8bit Command/ Address byte (bits R/W and A1-A7) and a subsequent 8bit data byte (bits D0-7). Bit R/W determines whether a read or a write operation occurs. Bits A5-0 in the Command/Address byte address specific registers (the address decoder ignores bits A7-6). The data byte depends on both the value of bit R/W and the address of the register as set in the Command/Address byte.



#### Figure 14. Serial Host Mode Timing

## 4.0 Register Descriptions

		Add	Iress	
Name	Symbol	Serial Port A7-A1	Parallel Port A7-A0	Mode
ID Register	ID	xx00000	xxx00000	R
Analog Loopback	ALOOP	xx00001	xxx00001	R/W
Remote Loopback	RLOOP	xx00010	xxx00010	R/W
TAOS Enable	TAOS	xx00011	xxx00011	R/W
LOS Status Monitor	LOS	xx00100	xxx00100	R
DFM Status Monitor	DFM	xx00101	xxx00101	R
LOS Interrupt Enable	LIE	xx00110	xxx00110	R/W
DFM Interrupt Enable	DIE	xx00111	xxx00111	R/W
LOS Interrupt Status	LIS	xx01000	xxx01000	R
DFM Interrupt Status	DIS	xx01001	xxx01001	R
Software Reset Register	RES	xx01010	xxx01010	R/W
Performance Monitoring	MON	xx01011	xxx01011	R/W
Digital Loopback	DL	xx01100	xxx01100	R/W
LOS/AIS Criteria Selection	LOSC	xx01101	xxx01101	R/W
Automatic TAOS Select	ATS	xx01110	xxx01110	R/W
Global Control Register	GCR	xx01111	xxx01111	R/W
Pulse Shaping Indirect Address Register	PSIAD	xx10000	xxx10000	R/W
Pulse Shaping Data Register	PSDAT	xx10001	xxx10001	R/W
Output Enable Register	OER	xx10010	xxx10010	R/W
AIS Status Register	AIS	xx10011	xxx10011	R
AIS Interrupt Enable	AISIE	xx10100	xxx10100	R/W
AIS Interrupt Status	AISIS	xx10101	xxx10101	R

#### Table 6. Serial and Parallel Port Register Addresses

#### Table 7. Register Bit Names

Register							Bit			
Name	Sym	RW	7	6	5	4	3	2	1	0
ID Register	ID	R	ID7	ID6	ID5	ID4	ID3	ID2	ID1	ID0
Analog Loopback	ALOOP	R/W	-	-	-	-	AL3	AL2	AL1	AL0
Remote Loopback	RLOOP	R/W	-	-	-	-	RL3	RL2	RL1	RL0
TAOS Enable	TAOS	R/W	-	-	-	-	TAOS3	TAOS2	TAOS1	TAOS0



Register			Bit							
Name	Sym	RW	7	6	5	4	3	2	1	0
LOS Status Monitor	LOS	R	-	-	-	-	LOS3	LOS2	LOS1	LOS0
DFM Status Monitor	DFM	R	-	-	-	-	DFM3	DFM2	DFM1	DFM0
LOS Interrupt Enable	LIE	R/W	-	-	-	-	LIE3	LIE2	LIE1	LIE0
DFM Interrupt Enable	DIE	R/W	-	-	-	-	DIE3	DIE2	DIE1	DIE0
LOS Interrupt Status	LIS	R	-	-	-	-	LIS3	LIS2	LIS1	LIS0
DFM Interrupt Status	DIS	R	-	-	-	-	DIS3	DIS2	DIS1	DIS0
Software Reset Register	RES	R/W	-	-	-	-	RES3	RES2	RES1	RES0
Performance Monitoring	MON	R/W	reserve d	reserve d	reserve d	reserve d	A3	A2	A1	A0
Digital Loopback	DL	R/W	-	-	-	-	DL3	DL2	DL1	DL0
LOS/AIS Criteria Select	LACS	R/W	-	-	-	-	LACS3	LACS2	LACS1	LACS0
Automatic TAOS Select	ATS	R/W	-	-	-	-	ATS3	ATS2	ATS1	ATS0
Global Control Register	GCR	R/W	reserve d	RAISE N	CDIS	CODEN	FIFO64	JACF	JASEL1	JASEL0
Pulse Shaping Indirect Address Register	PSIAD	R/W	reserve d	reserve d	reserve d	reserve d	reserve d	LENAD2	LENAD1	LENAD0
Pulse Shaping Data Register	PSDAT	R/W	reserve d	reserve d	reserve d	reserve d	reserve d	LEN2	LEN1	LEN0
Output Enable Register	OER	R/W	-	-	-	-	OE3	OE2	OE1	OE0
AIS Status Register	AIS	R	-	-	-	-	AIS3	AIS2	AIS1	AIS0
AIS Interrupt Enable	AISIE	R/W	-	-	-	-	AISIE3	AISIE2	AISIE1	AISIE0
AIS Interrupt Status	AISIS	R	-	-	-	-	AISIS3	AISIS2	AISIS1	AISIS0

#### Table 7. Register Bit Names (Continued)

#### Table 8.ID Register, ID (00H)

Bit	Name	Function
7-0	ID7-ID0	This register contains a unique revision code and is mask programmed. For Revision A1, ID register = 00h For Revision B1, ID register = 21h For Revision B2, ID register = 22h

#### Table 9. Analog Loopback Register, ALOOP (01H)

Bit	Name	Function
3-0	AL3-AL0	Setting a bit to "1" enables analog local loopback for transceivers 3- 0 respectively.

#### Table 10. Remote Loopback Register, RLOOP (02H)

Bit	Name	Function
3-0	RL3-RL0	Setting a bit to "1" enables remote loopback for transceivers 3-0 respectively.

#### Table 11. TAOS Enable Register, TAOS (03H)

Bit <sup>1</sup>	Name	Function <sup>2</sup>			
3-0	TAOS3-TAOS0	Setting a bit to "1" causes a continuous stream of marks to be sent out at the TTIP and TRING pins of the respective transceiver 3-0.			
7-4	-	Write "0" to these positions for normal operation.			
2. MCLK i	<ol> <li>On power up all register bits are set to "0".</li> <li>MCLK is used as timing reference. If MCLK is not available then the channel TCLK is used as the reference. This feature is not available then the channel TCLK is used as the reference. This feature is not available then the channel TCLK is used as the reference. This feature is not available then the channel TCLK is used as the reference. This feature is not available then the channel TCLK is used as the reference. This feature is not available then the channel TCLK is used as the reference. This feature is not available then the channel TCLK is used as the reference. This feature is not available then the channel TCLK is used as the reference. This feature is not available then the channel TCLK is used as the reference. This feature is not available then the channel TCLK is used as the reference. This feature is not available then the channel TCLK is used as the reference. This feature is not available then the channel TCLK is used as the reference. This feature is not available then the channel TCLK is used as the reference. This feature is not available then the channel TCLK is used as the reference. This feature is not available then the channel TCLK is used as the reference. This feature is not available then the channel TCLK is used as the reference. This feature is not available then the channel TCLK is used as the reference. This feature is not available then the channel TCLK is used as the reference. This feature is not available then the channel TCLK is used as the reference.</li> </ol>				

not available in data recovery and line driver mode (MCLK= High and TCLK = High)

#### Table 12. LOS Status Monitor Register, LOS (04H)

Bit <sup>1</sup>	Name	Function			
3-0	LOS3-LOS0	Respective bit(s) are set to "1" every time the LOS processor detects a valid loss of signal condition in transceivers 3-0.			
1. On power up all register bits are set to "0". Any change in the state causes an interrupt. All LOS interrupts are cleared by a single read operation.					

#### Table 13. DFM Status Monitor Register, DFM (05H)

Bit <sup>1</sup>	Name	Function		
3-0	DFM3-DFM0	Respective bit(s) are set to "1" every time the short circuit monitor detects a valid secondary output driver short circuit condition in transceivers 3-0. Note that DFM is available only in configurations with no transmit series resistors (T1 mode with TVCC=3.3V).		
1. On pow	1. On power-up all the register bits are set to "0". All DFM interrupts are cleared by a single read operation.			

#### Table 14. LOS Interrupt Enable Register, LIE (06H)

Bit <sup>1</sup>	Name	Function			
3-0	LIE3-LIE0	Transceiver 3-0 LOS interrupts are enabled by writing a "1" to the respective bit.			
7-4	-	Write "0" to these positions for normal operation.			
1. On pow	1. On power-up all the register bits are set to "0" and all interrupts are disabled.				

#### Table 15. DFM Interrupt Enable Register, DIE (07H)

Bit <sup>1</sup>	Name	Function		
3-0	DIE3-DIE0	Transceiver 3-0 DFM interrupts are enabled by writing a "1" to the respective bit.		
7-4	-	Write "0" to these positions for normal operation.		
1. On pow	1. On power-up all the register bits are set to "0" and all interrupts are disabled.			

#### Table 16. LOS Interrupt Status Register, LIS (08H)

Bit	Name	Function
3-0	LIS3-LIS0	These bits are set to "1" every time a LOS status change has occurred since the last clear interrupt in transceivers 3-0 respectively.

#### Table 17. DFM Interrupt Status Register, DIS (09H)

Bit	Name	Function
3-0	DIS3-DIS0	These bits are set to "1" every time a DFM status change has occurred since the last cleared interrupt in transceivers 3-0 respectively.

#### Table 18. Software Reset Register, RES (0AH)

Bit	Name	Function
3-0	RES3-RES0	Writing to this register initiates a 1 microsecond reset cycle, except for Intel non- multiplexed mode. When using Intel non-multiplexed host mode, extend cycle time to 2 microseconds. Please refer to Host Mode section for more information. This operation sets all LXT386 registers to their default values.

#### Table 19. Performance Monitoring Register, MON (0BH)

Bit	Name	Function
3-0	A3:A0	Protected Monitoring selection. See Table 1 on page 11.
4-7	reserved	Reserved.

#### Table 20. Digital Loopback Register, DL (0CH)

Bit <sup>1</sup>	Name	Function <sup>2</sup>	
3-0	DL3-DL0	Setting a bit to "1" enables digital loopback for the respective transceiver.	
2. During	1. On power up all register bits are set to "0".     2. During digital loopback LOS and TAOS stay active and independent of TCLK, while data received on TPOS/TNEG/TCKLK is looped back to RPOS/RNEG/RCLK.		

#### Table 21. LOS/AIS Criteria Register, LCS (0DH)

Bit <sup>1</sup>	Name	Function <sup>2</sup>	
		T1 Mode <sup>2</sup> Don't care. T1.231 compliant LOS/AIS detection is used.	
3-0	LCS3-LCS0 <sup>1</sup>	E1 Mode	
		Setting a bit to "1" selects the ETS1 300233 LOS. Setting a bit to "0" selects G.775 LOS mode. AIS works correctly for both ETSI and ITU when the bit is cleared to "0". See errata revision 10.3 or higher for a way to implement ETSI LOS and AIS.	
<ol> <li>On power-on reset the register is set to "0".</li> <li>T1 or E1 operation mode is determined by the PSDR settings.</li> </ol>			

у ngs.

#### Table 22. Automatic TAOS Select Register, ATS (0EH)

Bit <sup>1</sup>	Name	Function		
3-0	ATS3-ATS0	ATS3-ATS0 Setting a bit to "1" enables automatic TAOS generation whenever a LOS condition is detected in the respective transceiver.		
7-4	-	Write "0" to these positions for normal operation.		
	<ol> <li>On power-on reset the register is set to "0".</li> <li>This feature is not available in data recovery and line driver mode (MCLK= High and TCLK = High)</li> </ol>			

#### Table 23. Global Control Register, GCR (0FH)

Bit <sup>1</sup>	Name	Function			
0	JASEL0	These bits determine the jitter attenuator position:			
		JASEL0	JASEL1	JA Position	
		1	0	Transmit Path	
1	JASEL1	1	1	Receive Path	
		0	х	Disabled	
2	JACF			nuator low limit 3dB corner ils (Table 41 on page 58).	frequency. Refer to the Jitter
3	FIFO64	This bit determines the jitter attenuator FIFO depth: 0 = 32 bit 1 = 64 bit			
4	CODEN	This bit selects the zero suppression code for unipolar operation mode: 0 = B8ZS/HDB3 (T1/E1 respectively) 1 = AMI			
5	CDIS	This bit controls enables/disables the short circuit protection feature: 0 = enabled 1 = disabled			
6	RAISEN	This bit controls automatic AIS insertion in the receive path when LOS occurs: 0 = Receive AIS insertion disabled on LOS 1 = RPOS/RNEG = AIS on LOS Note: this feature is not available in data recovery mode (MCLK=High). Disable AIS			
		•	changing this bit	value to prevent inadverter	nt interrupts.
7	-	Reserved.			
1. On pow	er-on reset the register i	s set to "0".			

Bit <sup>1</sup>	Name	Function	
0-2	LENAD 0-2	The three bit value written to these bits determine the channel to be addressed: 0H = channel 0 1H = channel 1 2H = channel 2 3H = channel 3 Data can be read from (written to) the Pulse Shaping Data Register (PSDAT).	
3 - 7	-	Reserved.	
1. On pow	1. On power-on reset the register is set to "0".		

#### Table 24. Pulse Shaping Indirect Address Register, PSIAD (10H)

### Table 25. Pulse Shaping Data Register, PSDAT (11H)

Bit	Name		Function					
		LEN2-0	LEN0-2 determine the LXT386 operation mode: T1 or E1. In addition, for T1 operation, LEN2-0 set the pulse shaping to meet the T1.102 pulse template at the DSX-1 cross-connect point for various cable lengths:					
		LEN2	LEN1	LEN0	Line Length	Cable Loss <sup>2</sup>	Operation Mode	
0.0	LEN 0-2 <sup>1, 3</sup>	0	1	1	0 - 133 ft. ABAM	0.6 dB		
0-2	LEIN 0-2 ","	1	0	0	133 - 266 ft. ABAM	1.2 dB		
		1	0	1	266 - 399 ft. ABAM	1.8 dB	T1	
		1	1	0	399 - 533 ft. ABAM	2.4 dB		
		1	1	1	533 - 655 ft. ABAM	3.0 dB		
		0	0	0	E1 G.703, 75 $\Omega$ coaxia twisted pair cable.	al cable and 120 $\Omega$	E1	
3 - 7	-	Reserve	d.		1		1	

Maximum cable loss at 772 KHz.
 When reading LEN, bit values appear inverted. "B1" revision silicon will fix this so the bits read back correctly.

#### Table 26. Output Enable Register, OER (12H)

Bit <sup>1</sup>	Name Function				
3-0	OE3 - OE0	Setting a bit to "1" tristates the output driver of the corresponding transceiver.			
1. On pow	1. On power-up all the register bits are set to "0".				

#### Table 27. AIS Status Monitor Register, AIS (13H)

Bit <sup>1</sup>	Name	Function			
3-0	AIS3-AIS0	Respective bit(s) are set to "1" every time the receiver detects a AIS condition in transceivers 3-0.			
1. On pow	1. On power-up all the register bits are set to "0". All AIS interrupts are cleared by a single read operation.				

#### Table 28. AIS Interrupt Enable Register, AISIE (14H)

Bit <sup>1</sup>	Name	Function		
3-0	AISIE3-AISIE0	Transceiver 3-0 AIS interrupts are enabled by writing a "1" to the respective bit.		
7-4	-	- Write "0" to these positions for normal operation.		
1. On pow	1. On power-up all the register bits are set to "0".			

#### Table 29. AIS Interrupt Status Register, AISIS (15H)

Bit <sup>1</sup>	Name	Function				
3-0	AISIS3-AISIS0	These bits are set to "1" every time a AIS status change has occurred since the last clear interrupt in transceivers 3-0 respectively.				
1. On pow	1. On power-up all the register bits are set to "0".					

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## 5.0 JTAG Boundary Scan

## 5.1 Overview

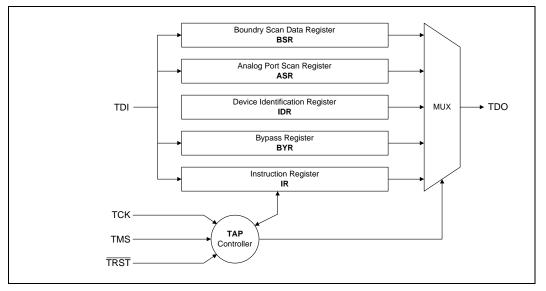
The LXT386 supports IEEE 1149.1 compliant JTAG boundary scan. Boundary scan allows easy access to the interface pins for board testing purposes.

In addition to the traditional IEE1149.1 digital boundary scan capabilities, the LXT386 also includes analog test port capabilities. This feature provides access to the TIP and RING signals in each channel (transmit and receive). This way, the signal path integrity across the primary winding of each coupling transformer can be tested.

## 5.2 Architecture

Figure 15 represents the LXT386 basic JTAG architecture. The LXT386 JTAG architecture includes a TAP Test Access Port Controller, data registers and an instruction register. The following paragraphs describe these blocks in detail.

#### Figure 15. LXT386 JTAG Architecture



## 5.3 TAP Controller

The TAP controller is a 16 state synchronous state machine controlled by the TMS input and clocked by TCK (Figure 16). The TAP controls whether the LXT386 is in reset mode, receiving an instruction, receiving data, transmitting data or in an idle state. Table 30 describes in detail each of the states represented in Figure 16.

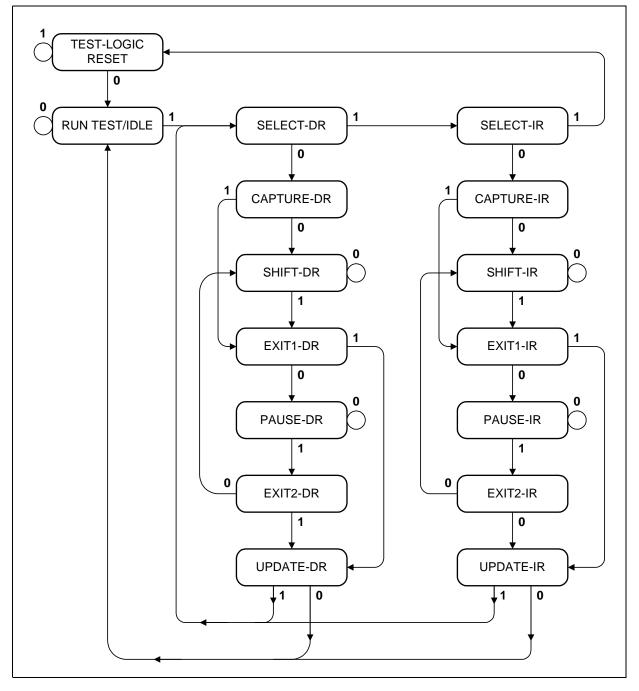


Table 30.	TAP	State	Descrip	otion
-----------	-----	-------	---------	-------

State	Description
Test Logic Reset	In this state the test logic is disabled. The device is set to normal operation mode. While in this state, the instruction register is set to the ICODE instruction.
Run -Test/Idle	The TAP controller stays in this state as long as TMS is low. Used to perform tests.
Capture - DR	The Boundary Scan Data Register (BSR) is loaded with input pin data.
Shift - DR	Shifts the selected test data registers by one stage tword its serial output.
Update - DR	Data is latched into the parallel output of the BSR when selected.
Capture - IR	Used to load the instruction register with a fixed instruction.
Shift - IR	Shifts the instruction register by one stage.
Update - IR	Loads a new instruction into the instruction register.
Pause - IR Pause - DR	Momentarily pauses shifting of data through the data/instruction registers.
Exit1 - IR Exit1 - DR Exit2 - IR Exit2 - DR	Temporary states that can be used to terminate the scanning process.



Figure 16. JTAG State Diagram



## 5.4 JTAG Register Description

The following paragraphs describe each of the registers represented in Figure 15.

#### **Boundary Scan Register (BSR)** 5.4.1

The BSR is a shift register that provides access to all the digital I/O pins. The BSR is used to apply and read test patterns to/from the board. Each pin is associated with a scan cell in the BSR register. Bidirectional pins or tristatable pins require more than one position in the register. Table 1 shows the BSR scan cells and their functions. Data into the BSR is shifted in LSB first.

Bit #	Pin Signal	l/O Type	Bit Symbol	Comments
0	LOS3	0	LOS3	
	RNEG3	0	RNEG3	
	N/A	-	HIZ3	HIZ3 controls the RPOS3, RNEG3 and RCLK3 pins. Setting HIZ3 to "0" enables output on the pins. Setting HIZ3 to "1" tristates the pins.
	RPOS3	0	RPOS3	
	RCLK3	0	RCLK3	
	TNEG3	I	TNEG3	
	TPOS3	I	TPOS3	
	TCLK3	I	TCLK3	
	LOS2	0	LOS2	
	RNEG2	0	RNEG2	
	N/A	-	HIZ2	HIZ2 controls the RPOS2, RNEG2 and RCLK2 pins. Setting HIZ2 to "0" enables output on the pins. Setting HIZ2 to "1" tristates the pins.
	RPOS2	0	RPOS2	
	RCLK2	0	RCLK2	
	TNEG2	I	TNEG2	
	TPOS2	I	TPOS2	
	TCLK2	I	TCLK2	
	MCLK	I	MCLK	
	MODE	I	MODE	
	INT	0	INTRUPTB	
	N/A	-	SDORDYENB	SDORDYENB controls the ACK pin. Setting SDORDYENB to "0" enables output on ACK pin. Setting SDORDYENB to "1" tristates the pin.
	ACK	0	SDORDY	
	ALE	I	ALE	
	OE	I	OE	
	CLKE	I	CLKE	
	A0	I	A0	
	A1	I	A1	
	A2	I	A2	
	A3	I	A3	
	A4	I	A4	
	LOOP0	I/O	PADD0	

#### Example 1. Boundary Scan Register (BSR)

Datasheet





Bit #	Pin Signal	I/O Type	Bit Symbol	Comments
	LOOP0	I/O	PDO0	
	LOOP1	I/O	PADI1	
	LOOP1	I/O	PDO1	
	LOOP2	I/O	PADI2	
	LOOP2	I/O	PDO2	
	LOOP3	I/O	PADI3	
	LOOP3	I/O	PDO3	
	LOOP4	I/O	PADI4	
	LOOP4	I/O	PDO4	
	LOOP5	I/O	PADI5	
	LOOP5	I/O	PDO5	
	LOOP6	I/O	PADI6	
	LOOP6	I/O	PDO6	
	LOOP7	I/O	PADI7	
				PDOENB controls the LOOP0 through LOOP7 pins.
	N/A	-	PDOENB	Setting PDOENB to "0" configures the pins as outputs. The output value to the pin is set in PDO[07]. Setting PDOENB to "1" tristates all the pins. The input value to the pins
				can be read in PADD[07].
	LOOP7	I/O	PDO7	
	CS	I	CSB	
	MUX	I	MUX	
	RESET	I	RSTB	
	MOT/INTL	I	IMB	
	R/W	I	RDB	
	DS	I	WRB	
	TCLK1	I	TCLK1	
	TPOS1	I	TPOS1	
	TNEG1	I	TNEG1	
	RCLK1	0	RCLK1	
	RPOS1	0	RPOS1	
	N/A	-	HIZ1	HIZ1 controls the RPOS1, RNEG1 and RCLK1 pins. Setting HIZ1 to "0" enables output on the pins. Setting HIZ1 to "1" tristates the pins.
	RNEG1	0	RNEG1	
	LOS1	0	LOS1	
	TCLK0	I	TCLK0	
	TPOS0	I	TPOS0	
	TNEG0	I	TNEG0	
	RCLK0	0	RCLK0	

#### Example 1. Boundary Scan Register (BSR) (Continued)



#### Example 1. Boundary Scan Register (BSR) (Continued)

Bit #	Pin Signal	l/O Type	Bit Symbol	Comments		
	RPOS0	0	RPOS0			
	N/A	-	HIZ0	HIZ0 controls the RPOS0, RNEG0 and RCLK0 pins. Setting HIZ0 to "0" enables output on the pins. Setting HIZ0 to "1" tristates the pins.		
	RNEG0	0	RNEG0			
	LOS0	0	LOS0			

### 5.5 Device Identification Register (IDR)

The IDR register provides access to the manufacturer number, part number and the LXT386 revision. The register is arranged per IEEE 1149.1 and is represented in Table 31. Data into the IDR is shifted in LSB first.

Table 31. Device Identification	<b>Register (ID</b>	R)
---------------------------------	---------------------	----

Bit #	Comments
31 - 28	Revision Number
27 - 12	Part Number
11 - 1	Manufacturer Number
0	Set to "1"

#### 5.5.1 Bypass Register (BYR)

The Bypass Register is a 1 bit register that allows direct connection between the TDI input and the TDO output.

#### 5.5.2 Analog Port Scan Register (ASR)

The ASR is a 5 bit shift register used to control the analog test port at pins AT1, AT2. When the INTEST\_ANALOG instruction is selected, TDI connects to the ASR input and TDO connects to the ASR output. After 5 TCK rising edges, a 5 bit control code is loaded into the ASR. Data into the ASR is shifted in LSB first.

Table 32 shows the 8 possible control codes and the corresponding operation on the analog port. The Analog Test Port can be used to verify continuity across the coupling transformers primary winding.

The Analog Test Port can be used to verify continuity across the coupling transformer's primary winding as shown in Figure 17. By applying a stimulus to the AT1 input, a known voltage will appear at AT2 for a given load. This, in effect, tests the continuity of a receive or transmit interface.

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ASR Control Code	AT1 Forces Voltage To:	AT2 Senses Voltage From:			
11111	TTIP0	TRING0			
11110	TTIP1	TRING1			
11101	TTIP2	TRING2			
11100	TTIP3	TRING3			
11011	Re	served			
11010	Re	served			
11001	Reserved				
11000	Reserved				
10111	RTIP0	RRING0			
10110	RTIP1	RRING1			
10101	RTIP2	RRING2			
10100	RTIP3	RRING3			
10011	Re	served			
10010	Reserved				
10001	Reserved				
10000	Re	served			

#### Table 32. Analog Port Scan Register (ASR)

### 5.5.3 Instruction Register (IR)

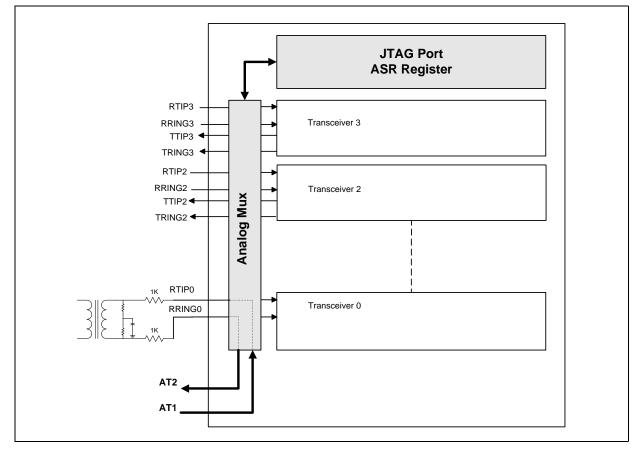
The IR is a 3 bit shift register that loads the instruction to be performed. The instructions are shifted LSB first. Table 33 shows the valid instruction codes and the corresponding instruction description.

Instruction Code #		Comments				
EXTEST 000		Connects the BSR to TDI and TDO. Input pins values are loaded into the BSR. Output pins values are loaded from the BSR.				
INTEST_ANALOG 010		Connects the ASR to TDI and TDO. Allows voltage forcing/sensing through AT1 and AT2. Refer to Table 32.				
SAMPLE / PRELOAD 100		Connects the BSR to TDI and TDO. The normal path between the LXT386 logic and the I/O pins is maintained. The BSR is loaded with the signals in the I/O pins.				
IDCODE	110	Connects the IDR to the TDO pin.				
BYPASS	111	Serial data from the TDI input is passed to the TDO output through the 1 bit Bypass Register.				

#### Table 33. Instruction Register (IR)



#### Figure 17. Analog Test Port Application



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## 6.0 Test Specifications

*Note:* Table 34 through Table 53 and Figure 18 through Figure 33 represent the performance specifications of the LXT386 and are guaranteed by test except, where noted, by design. The minimum and maximum values listed in Table 36 through Table 53 are guaranteed over the recommended operating conditions specified in Table 35.

#### Table 34. Absolute Maximum Ratings

Parameter	Symbol	Min	Мах	Unit
DC supply voltage	Vcc	-0.5	4.0	V
DC supply voltage	Tvcc 0-3	-0.5	7.0	V
Input voltage on any digital pin	Vin	GND-0.5	5.5	V
Input voltage on RTIP, RRING <sup>1</sup>	Vin	GND-0.5	Vcc + 0.5 Vcc + 0.5	V
ESD voltage on any Pin <sup>2</sup>	Vin	2000	-	V
Transient latch-up current on any pin	lin		100	mA
Input current on any digital pin <sup>3</sup>	lin	-10	10	mA
DC input current on TTIP, TRING <sup>3</sup>	lin	-	±100	mA
DC input current on RTIP, RRING <sup>3</sup>	lin	-	±100	mA
Storage temperature	Tstor	-65	+150	°C
Maximum power dissipation in package	P <sub>P</sub>		830	mW
Case Temperature, 100 pin LQFP package	T <sub>case</sub>	-	120	°C
Case Temperature, 160 pin PBGA package	T <sub>case</sub>	_	120	°C

*Caution:* Exceeding these values may cause permanent damage. Functional operation under these conditions is not implied. Exposure to absolute maximum rating conditions for extended periods may affect device reliability.

1. Referenced to ground.

2. Human body model.

3. Constant input current.

#### Table 35. Recommended Operating Conditions

Parameter	LEN	Sym	Min	Тур	Мах	Unit	Test Condition
Digital supply voltage (VCC)		VCC	3.135	3.3	3.465	V	3.3V ± 5%
Transmitter supply voltage, TVCC=5V nominal		TVCC	4.75	5.0	5.25	V	5V ± 5%
Transmitter supply voltage, TVCC=3.3V nominal		TVCC	3.135	3.3	3.465	V	3.3V ± 5%
Ambient operating temperature		Та	-40	25	+85	°C	

1. Maximum power and current consumption over the full operating temperature and power supply voltage range. Includes all channels.

2. Power consumption includes power absorbed by line load and external transmitter components.

3. T1 maximum values measured with maximum cable length (LEN = 111). Typical values measured with typical cable length (LEN = 101).

4. Digital inputs are within 10% of the supply rails and digital outputs are driving a 50pF load.

#### Table 35. Recommended Operating Conditions (Continued)

	Parameter		LEN	Sym	Min	Тур	Max	Unit	Test Condition
Average Transmitter Power Supply Current, T1 Mode <sup>1, 2, 3</sup>			I <sub>TVCC</sub>	-	215 110	245 -	mA mA	100% 1's 50% 1's	
Average Digi	tal Power Suppl	y Current <sup>1, 4</sup>		I <sub>VCC</sub>	-	50	60	mA	
Output load a	at TTIP and TRI	NG		RI	25	-	-	Ω	
			Device P	ower Cons	sumption				
Mode	тусс	Load	LEN			Тур	Max <sup>1,2</sup>	Unit	Test Condition
75 Ω	75.0	000	-	-	440	-	mW	50% 1's	
E1	3.3V	75 \2	000	-	-	-	680	mW	100% 1's
El	3.3V	100.0	000	-	-	400	-	mW	50% 1's
		120 Ω	000	-	-	-	600	mW	100% 1's
T1 <sup>3</sup>	3.3V	100.0	101 111	-	-	550	-	mW	50% 1's
11-	3.3V	100 Ω	101-111	-	-	-	1025	mW	100% 1's
		75.0	000	-	-	610	-	mW	50% 1's
	5.01/	75 Ω	000	-	-	-	930	mW	100% 1's
E1	5.0V	120.0	000	-	-	540	-	mW	50% 1's
120	120 Ω	000	-	-	-	810	mW	100% 1's	
T1 <sup>3</sup>	E 0)/	100.0	101 111	-	-	830	-	mW	50% 1's
11.	5.0V	100 Ω	101-111	-	-	-	1400	mW	100% 1's

1. Maximum power and current consumption over the full operating temperature and power supply voltage range. Includes all channels.

2. Power consumption includes power absorbed by line load and external transmitter components.

3. T1 maximum values measured with maximum cable length (LEN = 111). Typical values measured with typical cable length (LEN = 101).

4. Digital inputs are within 10% of the supply rails and digital outputs are driving a 50pF load.

#### Table 36. DC Characteristics

	Parameter	Sym	Min	Тур	Мах	Unit	Test Condition
High level in	gh level input voltage		Vih 2				
Low level inp	out voltage	Vil –		-	- 0.8		
High level ou	utput voltage <sup>1</sup>	Voh	2.4	-	VCC	V	IOUT= 400µA
Low level output voltage <sup>1</sup>		Vol	-	-	0.4	V	IOUT= 1.6mA
	Low level input voltage	Vinl	-	-	1/3VCC-0.2	V	
MODE, LOOP0-3	Midrange level input voltage	Vinm	1/3VCC+0.2	1/2VCC	2/3VCC-0.2	V	
and	High level input voltage	Vinh	2/3VCC+0.2	-	-	V	
JASEL	Low level input current	linl	-	-	50	μA	
	High level input current	linh	-	-	50	μA	
1. Output d	rivers will output CMOS log	ic levels ir	nto CMOS loads.		•		•



#### Table 36. DC Characteristics (Continued)

Parameter	Sym	Min	Тур	Мах	Unit	Test Condition
Input leakage current	lil	-10		+10	μA	
Tri state leakage current	lhz	-10		+10	μA	
Tri state output current	lhz	_	-	1	μA	TTIP, TRING
Line short circuit current	_	_	-	50	mA RMS	$2 \times 11 \Omega$ series resistors and 1:2 transformer
Input Leakage (TMS, TDI, TRST)	-	-	-	50	μA	
1. Output drivers will output CMOS log	ic levels ir	to CMOS loads.				

#### Table 37. E1 Transmit Transmission Characteristics

P	arameter	Sym	Min	Тур	Max	Unit	Test Condition
Output pulse amplitude	75Ω 120Ω	-	2.14 2.7	2.37 3.0	2.60 3.3	V V	Tested at the line side
Peak voltage of a	0		-0.237		0.237	V	
space         120Ω           Transmit amplitude variation with supply		_	-0.3 -1		0.3 +1	V %	
Difference between p	oulse sequences	-			200	mV	For 17 consecutive pulses
Pulse width ratio of the positive and negative pulses		-	0.95		1.05		At the nominal half amplitude
Transmit transformer turns ratio for 75/120Ω characteristic impedance		-		1:2			Rt = 11 Ω ± 1%
Transmit return loss 75 $\Omega$ coaxial cable <sup>1</sup>	51kHz to 102 kHz 102 kHz to 2.048 MHz 2.048 MHz to 3.072 MHz	_	15 15 15	17 17 17	_	dB dB dB	Using components in the LXD384 evaluation board.
Transmit return loss 120 $\Omega$ twisted pair cable <sup>1</sup>	51kHz to 102 kHz 102 kHz to 2.048 MHz 2.048 MHz to 3.072 MHz	_	15 15 15	20 20 20	_	dB dB dB	Using components in the LXD384 evaluation board.
Transmit intrinsic jitte	er; 20Hz to 100kHz	-	-	0.030	0.050	U.I.	Tx path TCLK is jitter free
Transmit path delay	Bipolar mode			2		U.I.	JA Disabled
	Unipolar mode esign and other correlation me	ethods.		7		U.I.	

#### Table 38. E1 Receive Transmission Characteristics

Parameter	Sym	Min	Тур	Max	Unit	Test Condition				
Permissible cable attenuation	-	-	-	12	dB	@1024 kHz				
Receiver dynamic range	DR	0.5	-	-	Vp					
Signal to noise interference margin	S/I	-15	_	_	dB	Per G.703, O.151 @ 6 dB cable Attenuation				
1. Guaranteed by design and other correlation	1. Guaranteed by design and other correlation methods.									



	Parameter	Sym	Min	Тур	Max	Unit	Test Condition	
Data decision	threshold	SRE	43	50	57	%	Rel. to peak input voltage	
Data slicer threshold		-	-	150	-	mV		
Loss of signa	I threshold	-	-	200	-	mV		
LOS hysteresis		-	-	50	-	mV		
Consecutive zeros before loss of signal		-	-	32 2048	-	-	G.775 recommendation ETSI 300 233 specification	
LOS reset		-	12.5%	-	-	-	1's density	
Low limit input jitter tolerance <sup>1</sup>	1Hz to 20Hz 20Hz to 2.4kHz 18kHz to 100kHz	_	36 1.5 0.2	_	_	U.I. U.I. U.I.	G735 recommendation Note 1 Cable Attenuation is 6 dB	
Differential receiver input impedance		-	-	70	-	kΩ	@1.024 MHz	
Input termination resistor tolerance		-	-	-	±1	%		
Common mod	de input impedance to ground	-	-	20	-	kΩ		
Input return Ioss <sup>1</sup>	51 kHz - 102 kHz 102 - 2048 kHz 2048kHz - 3072 kHz	_	20 20 20		_	dB dB dB	Measured against nominal impedance using components in the LXD384 evaluation board.	
LOS delay tin	ne	-	-	30	-	μs	Data recovery mode	
LOS reset		-	10	-	255	marks	Data recovery mode	
Receive intrin	sic jitter, RCLK output	-	-	0.040	0.0625	U.I.	Wide band jitter	
Receive	Bipolar mode			1		U.I.		
path delay	Unipolar mode		1	6		U.I.	JA Disabled	

#### Table 38. E1 Receive Transmission Characteristics (Continued)

#### Table 39. T1 Transmit Transmission Characteristics

	Parameter	Sym	Min	Тур	Max	Unit	Test Condition
Output pulse amplitude		-	2.4	3.0	3.6	V	Measured at the DSX
Peak voltage of a space		-	-0.15	-	+0.15	V	
Driver output impedance <sup>1</sup>		-	-	1	-	Ω	@ 772 KHz
Transmit amplitude variation with power supply		-	-1	-	+1	%	
Ratio of positive to negative pulse amplitude		-	0.95	-	1.05	-	T1.102, isolated pulse
Difference betweer	Difference between pulse sequences		-	-	200	mV	For 17 consecutive
Pulse width variation	on at half amplitude	-	-	-	20	ns	pulses, GR-499-CORE
Jitter added by Transmitter <sup>1</sup>	10Hz - 8KHz 8KHz - 40KHz 10Hz - 40KHz Wide Band	-	-	-	0.020 0.025 0.025 0.050	UI <sub>pk-pk</sub>	AT&T Pub 62411 TCLK is jitter free.
	design and other correlation me d in a 3 KHz bandwidth at the p		gnal arriv	es at the o	distributior	n frame for a	an all 1's pattern.



Р	Parameter		Min	Тур	Max	Unit	Test Condition	
Output power levels <sup>2</sup>	@ 772 KHz @ 1544 KHz	-	12.6 -29	-	17.9	dBm dBm	T1.102 - 1993 Referenced to power at 772 KHz	
Transmit return loss <sup>1</sup>	51kHz to 102 kHz 102 kHz to 2.048 MHz 2.048 MHz to 3.072 MHz	_	15 15 15	21 21 21	-	dB dB dB	With transmit series resistors (TVCC=5V). Using components in the LXD384 evaluation board.	
Transmit path delay	Bipolar mode			2		U.I.	JA Disabled	
Transmit path delay	Unipolar mode			7		U.I.	- JA Disabled	

#### Table 39. T1 Transmit Transmission Characteristics (Continued)

#### Table 40. T1 Receive Transmission Characteristics

Parameter		Sym	Min	Тур	Мах	Unit	Test Condition
Permissible ca	able attenuation	-	-	-	12	dB	@ 772 KHz
Receiver dyna	Receiver dynamic range		0.5	-	-	Vp	
Signal to noise	e interference margin	S/I	-16.5	-	-	dB	@ 655 ft. of 22 ABAM cable
Data decision	threshold	SRE	63	70	77	%	Rel. to peak input voltage
Data slicer thr	eshold	-	-	150	-	mV	
Loss of signal	threshold	-	-	200	-	mV	
LOS hysteresi	S	-	-	50	-	mV	
Consecutive z	eros before loss of signal	-	100	175	250	-	T1.231 - 1993
LOS reset		-	12.5%	-	-	-	1's density
Low limit input jitter tolerance <sup>1</sup>	0.1Hz to 1Hz 4.9Hz to 300Hz 10KHz to 100KHz	-	138 28 0.4	-	-	U.I. U.I. U.I.	AT&T Pub. 62411
Differential rec	ceiver input impedance	-	-	70	-	kΩ	@772 kHz
Input terminati	ion resistor tolerance	-	-		±1	%	
Common mod	e input impedance to ground	-	-	20	-	kΩ	
Input return loss <sup>1</sup>	51 KHz - 102 KHz 102 - 2048 KHz 2048 KHz - 3072 KHz	-	20 20 20	-	-	dB dB dB	Measured against nominal impedance. Using components in the LXD384 evaluation board.
LOS delay tim	е	-	-	30	-	μs	Data recovery mode
LOS reset		-	10	-	255	-	Data recovery mode
Receive intrins	sic jitter, RCLK output <sup>1</sup>	-	-	0.035	0.0625	U.I.	Wide band jitter
Receive	Bipolar mode			1		U.I.	JA Disabled
path delay	Unipolar mode			6		U.I.	- JA DISADIEO
1. Guarantee	d by design and other correlatio	n methods	3.	•	•	•	•



#### **Table 41. Jitter Attenuator Characteristics**

Para	meter		Min	Тур	Max	Unit	Test Condition
	JACF = 0	32bit FIFO	-	2.5	-	Hz	
E1 jitter attenuator 3dB corner frequency, host	JACF = 0	64bit FIFO	-	3.5	-	Hz	
mode <sup>1</sup>	JACF = 1	32bit FIFO	-	2.5	-	Hz	
	5401 - 1	64bit FIFO	-	3.5	-	Hz	
	JACF = 0	32bit FIFO	-	3	-	Hz	Sinusoidal jitter modulation
T1 jitter attenuator 3dB corner frequency, host		64bit FIFO	-	3	-	Hz	
mode <sup>1</sup>	JACF = 1	32bit FIFO	-	6	-	Hz	
		64bit FIFO	-	6	-	Hz	
Jitter attenuator 3dB co		E1	-	3.5	-	Hz	
frequency, hardware mo	ode <sup>1</sup>	T1	-	6	-	Hz	
Data latency delay		32bit FIFO	-	17	-	UI	Delay through the Jitter attenuator only. Add receive and transmit path
		64bit FIFO	-	33	-	UI	delay for total throughput delay.
Input jitter tolerance bef	ore FIFO	32bit FIFO	-	24	-	UI	
overflow or underflow		64bit FIFO	-	56	-	UI	
E1 jitter attenuation	⊉ 3 Hz	@ 40 Hz @ 400 Hz @ 100 KHz	-0.5 -0.5 +19.5 +19.5	_	_	dB	ITU-T G.736 (Figure 34 on page 74)
T1 jitter attenuation	⊉ 1 Hz	@ 20 Hz @ 1 KHz @ 1.4 KHz @ 70 KHz	0 0 33.3 40 40	_	_	dB	AT&T Pub. 62411 (Figure 34 on page 74)
Output Jitter in remote I	oopback <sup>1</sup>			0.060	0.11	UI	ETSI CTR12/13 Output jitter
1. Guaranteed by desig	gn and other co	rrelation m	nethods.				1

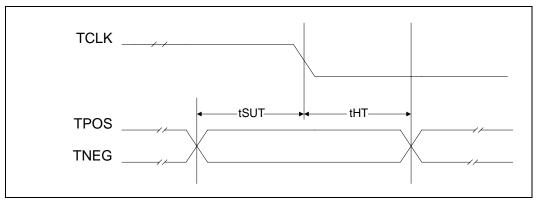


Parameter	Sym	Min	Тур	Max	Unit	Test Condition
3 dB bandwidth	At13db	-	5	-	MHz	
Input voltage range	At1iv	0	-	VCC	V	
Output voltage range	At2ov	0	-	VCC	V	

#### Table 43. Transmit Timing Characteristics

Parameter		Sym	Min	Тур	Max	Unit	Test Condition
Master clock frequency	E1	MCLK	-	2.048	-	MHz	
	T1	MCLK	-	1.544	-	MHz	
Master clock tolerance		-	-100	-	100	ppm	
Master clock duty cycle		-	40	-	60	%	
Output pulse width		Tw	219	244	269	ns	
	T1	Tw	291	324	356	ns	
Transmit clock frequency	E1	Tclke1	-	2.048	-	MHz	
Transmit clock nequency	T1	Tclkt1	-	1.544	-	MHz	
Transmit clock tolerance		Tclkt	-50	-	+50	ppm	
Transmit clock burst rate		Tclkb	-	-	20	MHz	Gapped transmit clock
Transmit clock duty cycle		Tdc	10	-	90	%	NRZ mode
E1 TPOS/TNEG pulse width (RZ mod	e)	Tmpwe1	236	_	252	ns	RZ mode (TCLK = H for >16 clock cycles)
TPOS/TNEG to TCLK setup time		Tsut	20	-	-	ns	
TCLK to TPOS/TNEG hold time		Tht	20	-	-	ns	
Delay time OE Low to driver High Z		Toez	-	-	1	μs	
Delay time TCLK Low to driver High Z		Ttz	50	60	75	μs	

#### Figure 18. Transmit Clock Timing Diagram





#### **Table 44. Receive Timing Characteristics**

Parameter		Sym	Min	Тур	Max	Unit	Test Condition
	E1	-	-	±80	-	ppm	Relative to nominal frequency
Clock recovery capture range	T1	-	_	±180	_	ppm	MCLK = ±100 ppm
Receive clock duty cycle <sup>1</sup>		Rckd	40	50	60	%	
Receive clock pulse width <sup>1</sup>	E1	Tpw	447	488	529	ns	
Receive clock pulse width	T1	Tpw	583	648	713	ns	
Receive clock pulse width Low time	E1	Tpwl	203	244	285	ns	
Receive clock pulse width Low time	T1	Tpwl	259	324	389	ns	
Possive clock pulse width High time	E1	Tpwh	203	244	285	ns	
Receive clock pulse width High time	T1	Tpwh	259	324	389	ns	
Rise/fall time <sup>4</sup>		Tr	20	-	-	ns	@ CL=15 pF
RPOS/RNEG pulse width (MCLK=H) <sup>2</sup>	E1	Tpwdl	200	244	300	ns	
RF03/RNEG puise width (MCER=H)	T1	Tpwdl	250	324	400	ns	
RPOS/RNEG to RCLK rising setup time	E1	Tsur	200	244	-	ns	
KPOS/KNEG to KCEK fising setup time	T1	1501	200	324	-	ns	
RCLK Rising to RPOS/RNEG hold time	E1	Thr	200	244	-	ns	
ROLK RISING IO REOS/RIVEG HOLD LITTE	T1		200	324	—	ns	1
Delay time between RPOS/RNEG and RCL	ĸ	- 1	_	-	5	ns	MCLK = H <sup>3</sup>

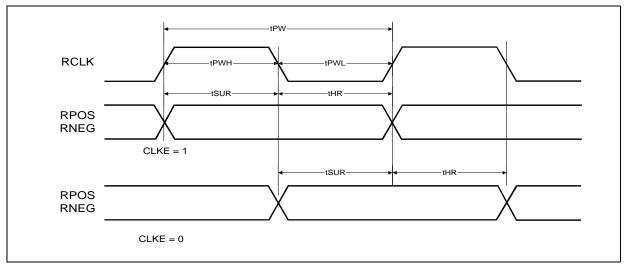
duty cycles are for worst case jitter conditions (0.2UI displacement for E1 per ITU G.823).

2. Clock recovery is disabled in this mode.

3. If MCLK = H the receive PLLs are replaced by a simple EXOR circuit.

4. For all digital outputs.

#### Figure 19. Receive Clock Timing Diagram

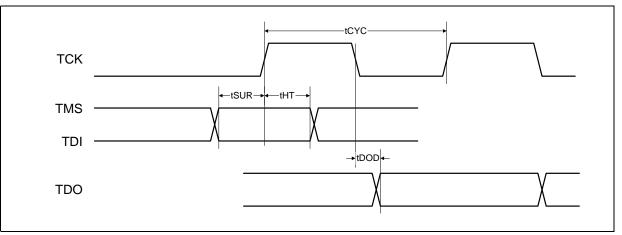




#### Table 45. JTAG Timing Characteristics

Parameter	Sym	Min	Тур	Max	Unit	Test Conditions
Cycle time	Тсус	200	-	-	ns	
J-TMS/J-TDI to J-TCK rising edge time	Tsut	50	-	-	ns	
J-CLK rising to J-TMS/L-TDI hold time	Tht	50	-	-	ns	
J-TCLK falling to J-TDO valid	Tdod	-	-	50	ns	

#### Figure 20. JTAG Timing

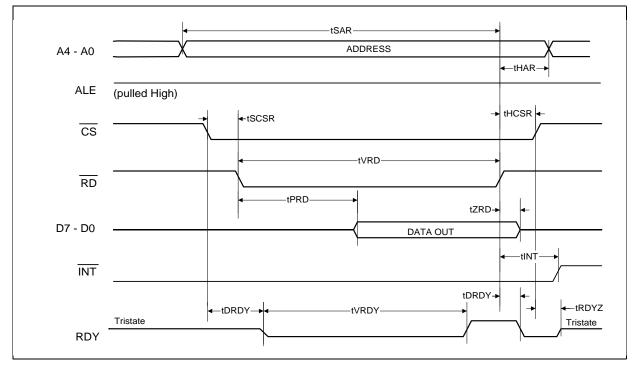


#### Table 46. Intel Mode Read Timing Characteristics

Parameter <sup>2</sup>	Sym	Min	Typ <sup>1</sup>	Max	Unit	Test Conditions
Address setup time to latch	Tsalr	10	-	-	ns	
Valid address latch pulse width	Tvl	30	-	-	ns	
Latch active to active read setup time	Tslr	10	-	-	ns	
Chip select setup time to active read	Tscsr	0	-	-	ns	
Chip select hold time from inactive read	Thcsr	0	-	-	ns	
Address hold time from inactive ALE	Thalr	5			ns	
Active read to data valid delay time	Tprd	10	-	50	ns	
Address setup time to RD inactive	Thar	1	-	-	ns	
Address hold time from RD inactive	Tsar	5	-	-	ns	
Inactive read to data tri-state delay time	Tzrd	3	-	35	ns	
Valid read signal pulse width	Tvrd	60	-	-	ns	
Inactive read to inactive INT delay time	Tint	-	-	10	ns	
Active chip select to RDY delay time	Tdrdy	0	-	12	ns	
Active ready Low time	Tvrdy	-	-	40	ns	
Inactive ready to tri-state delay time	Trdyz	-	_	3	ns	

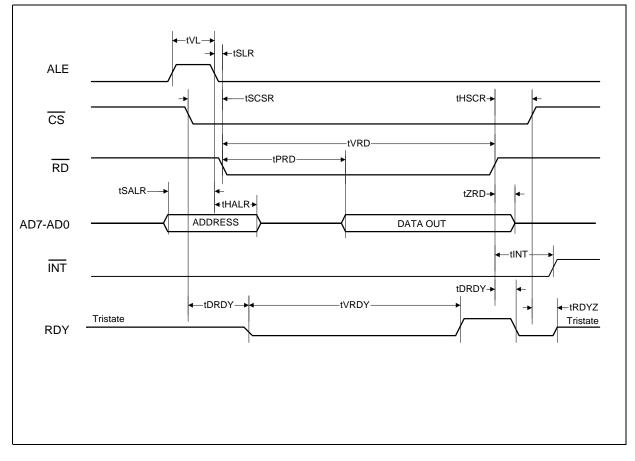






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#### **Table 47. Intel Mode Write Timing Characteristics**

Parameter <sup>2</sup>	Sym	Min	Typ <sup>1</sup>	Max	Unit	Test Conditions
Address setup time to latch	Tsalw	10	-	-	ns	
Valid address latch pulse width	Tvl	30	-	-	ns	
Latch active to active write setup time	Tslw	10	-	-	ns	
Chip select setup time to active write	Tscsw	0	-	-	ns	
Chip select hold time from inactive write	Thcsw	0	-	-	ns	
Address hold time from inactive ALE	Thalw	5			ns	
Data valid to write active setup time	Tsdw	40	-	-	ns	
Data hold time to active write	Thdw	30	-	-	ns	
Address setup time to $\overline{WR}$ inactive	Thaw	2	-	-	ns	
Address hold time from $\overline{WR}$ inactive	Tsaw	6	-	-	ns	

1. Typical figures are at 25 C and are for design aid only; not guaranteed and not subject to production testing. 2.  $C_L$ = 100pF on D0-D7, all other outputs are loaded with 50pF.

3. These times don't apply for Reset Register 0Ah, since RDY line goes low once during the cycle. Please refer to Reset Operation and Host Mode sections for more information.

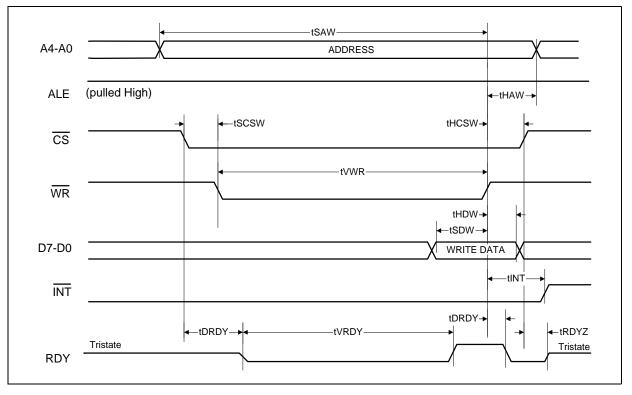
#### Table 47. Intel Mode Write Timing Characteristics (Continued)

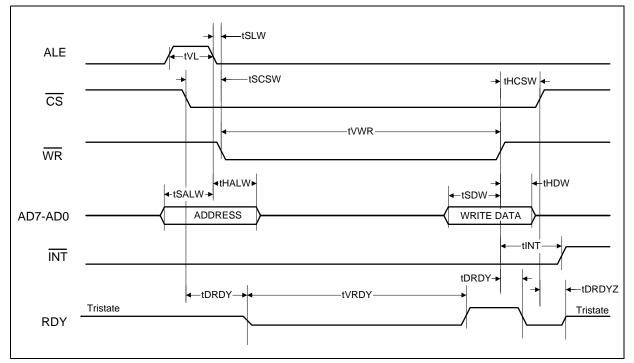
60 -	-	- 10	ns ns	
	-	10	ns	
0	-	12	ns	
-	-	40	ns	
-	-	3	ns	
ar	- - antee	 	3	

2.  $C_L$ = 100pF on D0-D7, all other outputs are loaded with 50pF.

3. These times don't apply for Reset Register 0Ah, since RDY line goes low once during the cycle. Please refer to Reset Operation and Host Mode sections for more information.

#### Figure 23. Non-Multiplexed Intel Mode Write Timing



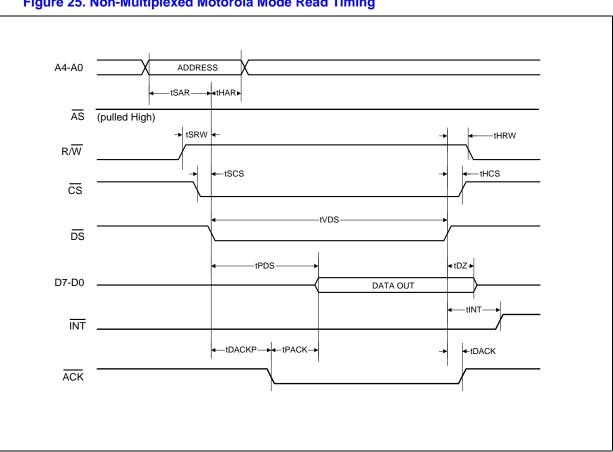


#### Figure 24. Multiplexed Intel Mode Write Timing

#### Table 48. Motorola Bus Read Timing Characteristics

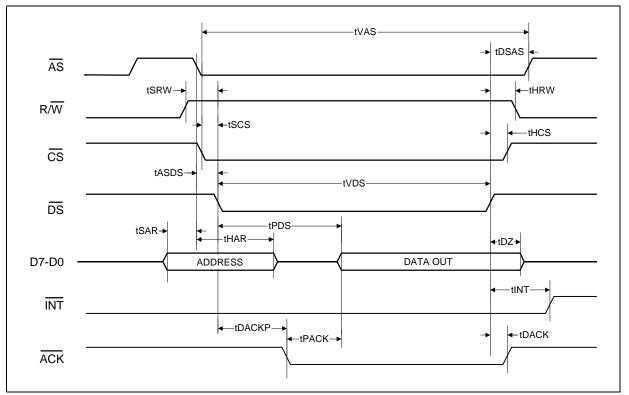
Parameter <sup>2</sup>	Sym	Min	Typ <sup>1</sup>	Max	Unit	Test Conditions
Address setup time to address or data strobe	Tsar	10	_	-	ns	
Address hold time from address or data strobe	Thar	5	-	-	ns	
Valid address strobe pulse width	Tvas	95	-	-	ns	
$R/\overline{W}$ setup time to active data strobe	Tsrw	10	-	-	ns	
$R/\overline{W}$ hold time from inactive data strobe	Thrw	0	-	-	ns	
Chip select setup time to active data strobe	Tscs	0	-	-	ns	
Chip select hold time from inactive data strobe	Thcs	0	-	-	ns	
Address strobe active to data strobe active delay	Tasds	20	-	-	ns	
Delay time from active data strobe to valid data	Tpds	3	-	30	ns	
Delay time from inactive data strobe to data High Z	Tdz	3	-	30	ns	
Valid data strobe pulse width	Tvds	60	-	-	ns	
Inactive data strobe to inactive INT delay time	Tint	-	-	10	ns	
Data strobe inactive to address strobe inactive delay	Tdsas	15	-	-	ns	
DS asserted to ACK asserted delay	Tdackp	-	-	40	ns	
DS deasserted to ACK deasserted delay	Tdack	-	-	10	ns	
Active ACK to valid data delay	Tpack	-	-	0	ns	

2.  $C_L$ = 100pF on D0-D7, all other outputs are loaded with 50pF.





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#### Figure 26. Multiplexed Motorola Mode Read Timing

#### Table 49. Motorola Mode Write Timing Characteristics

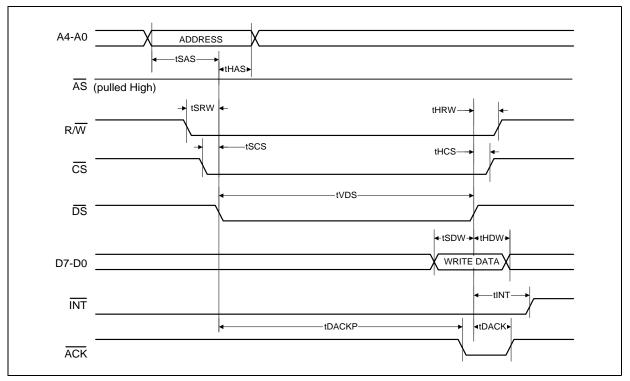
10 5 95 10 0 0	- - - - - -	- - - -	ns ns ns ns ns	
95 10 0	-	- - - -	ns	
10 0	-	- - -	ns	
0	-	-	-	
	-	_	ns	
0	-			
		-	ns	
0	-	-	ns	
20	-	-	ns	
40	-	-	ns	
30	-	-	ns	
60	-	-	ns	
- 1	-	10	ns	
v	s 20 v 40 v 30 s 60 -	s 20 – v 40 – v 30 – s 60 – – –	$\begin{array}{c ccccccccccccccccccccccccccccccccccc$	s     20     -     -     ns       v     40     -     -     ns       v     30     -     -     ns       s     60     -     -     ns



#### Table 49. Motorola Mode Write Timing Characteristics (Continued)

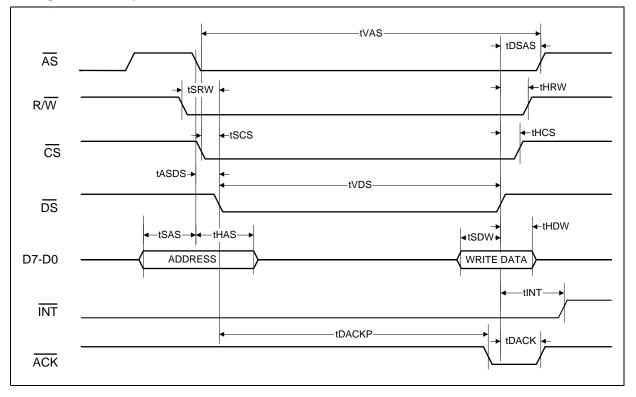
Parameter <sup>2</sup>	Sym	Min	Typ <sup>1</sup>	Max	Unit	Test Conditions
Data strobe inactive to address strobe inactive delay	Tdsas	15	-	-	ns	
Active data strobe to ACK output enable time	Tdack	0	-	12	ns	
DS asserted to ACK asserted delay	Tdackp		-	40	ns	
1. Typical figures are at 25 C and are for design aid only 2. $C_L$ = 100pF on D0-D7, all other outputs are loaded with		eed and	l not subje	ect to prod	uction testin	ig.

#### Figure 27. Non-Multiplexed Motorola Mode Write Timing





#### Figure 28. Multiplexed Motorola Mode Write Timin

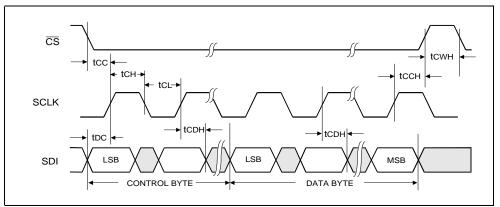


#### Table 50. Serial I/O Timing Characteristics

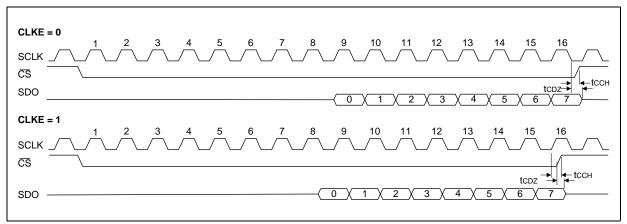
Parameter	Sym	Min	Typ <sup>1</sup>	Max	Unit	Test Condition
Rise/fall time any pin	Trf	-	-	100	ns	Load 1.6mA, 50 pF
SDI to SCLK setup time	Tdc	5	-	-	ns	
SCLK to SDI hold time	Tcdh	5	-	-	ns	
SCLK Low time	Tcl	25	-	-	ns	
SCLK High time	Tch	25	-	-	ns	
SCLK rise and fall time	Tr, Tf	-	-	50	ns	
CS falling edge to SCLK rising edge	Тсс	10	-	-	ns	
Last SCLK edge to $\overline{CS}$ rising edge	Tcch	10	-	-	ns	
CS inactive time	Tcwh	50	-	-	ns	
SCLK to SDO valid delay time	Tcdv	-	-	5	ns	
SCLK falling edge or $\overline{CS}$ rising edge to SDO High Z	Tcdz	-	10	-	ns	
1. Typical figures are at 25 $C^{\circ}$ and are for d	esign aid onl	y; not guara	inteed and n	ot subject to	production	testing.



#### Figure 29. Serial Input Timing



#### Figure 30. Serial Output Timing



#### Table 51. Transformer Specifications<sup>3</sup>

Tx/Rx	Turns Ratio <sup>1</sup>	Primary Inductance mH (min.)	Leakage Inductance μΗ (max.)	Interwinding Capacitance pF (max.)	DCR Ω (max.)	Dielectric Breakdown Voltage V <sup>2</sup> (min.)
тх	1:2	1.2	0.60	60	0.70 pri 1.20 sec	1500 Vrms
RX	1:2	1.2	0.60	60	1.10 pri 1.10 sec	1500 Vrms
1 Transfo	rmer turns ratio a	$1 \rightarrow 10^{-1}$				I

1. Transformer turns ratio accuracy is  $\pm$  2%.

1. This parameter is application dependent.LIU side: Line side.

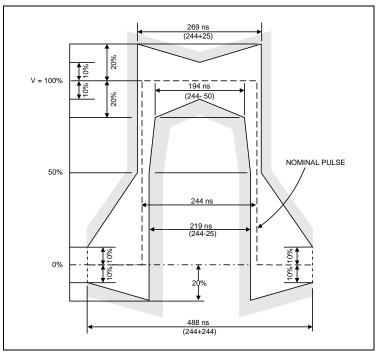
2. Refer to the FAQ or Application Note 118 for recommended magnetics.



#### Table 52. G.703 2.048 Mbit/s Pulse Mask Specifications

Personator	Ca	able	Unit	
Parameter	TWP	Coax	Unit	
Test load impedance	120	75	Ω	
Nominal peak mark voltage	3.0	2.37	V	
Nominal peak space voltage	0 ±0.30	0 ±0.237	V	
Nominal pulse width	244	244	ns	
Ratio of positive and negative pulse amplitudes at center of pulse	95-105	95-105	%	
Ratio of positive and negative pulse amplitudes at nominal half amplitude	95-105	95-105	%	

#### Figure 31. E1, G.703 Mask Templates

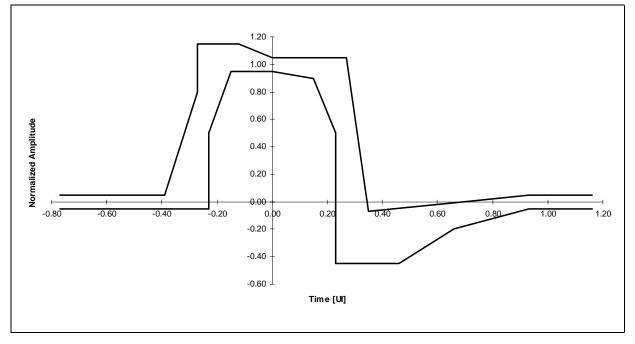


#### Table 53. T1.102 1.544 Mbit/s Pulse Mask Specifications

Parameter	Cable	Unit
	ТWP	
Test load impedance	100	Ω
Nominal peak mark voltage	3.0	V
Nominal peak space voltage	0 ±0.15	V
Nominal pulse width	324	ns
Ratio of positive and negative pulse amplitudes	95-105	%







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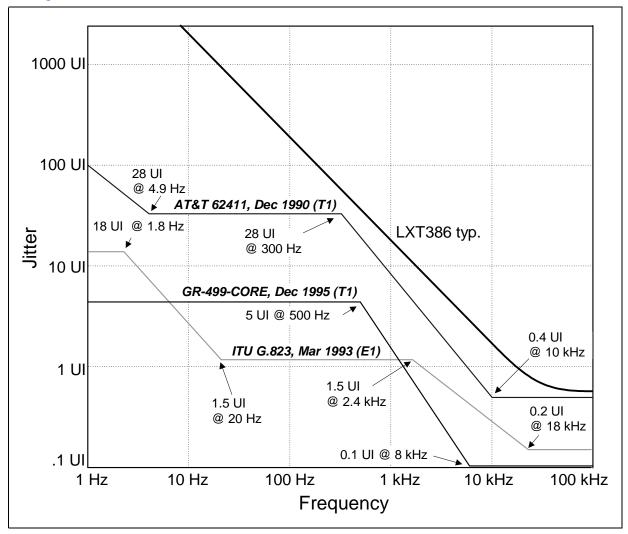
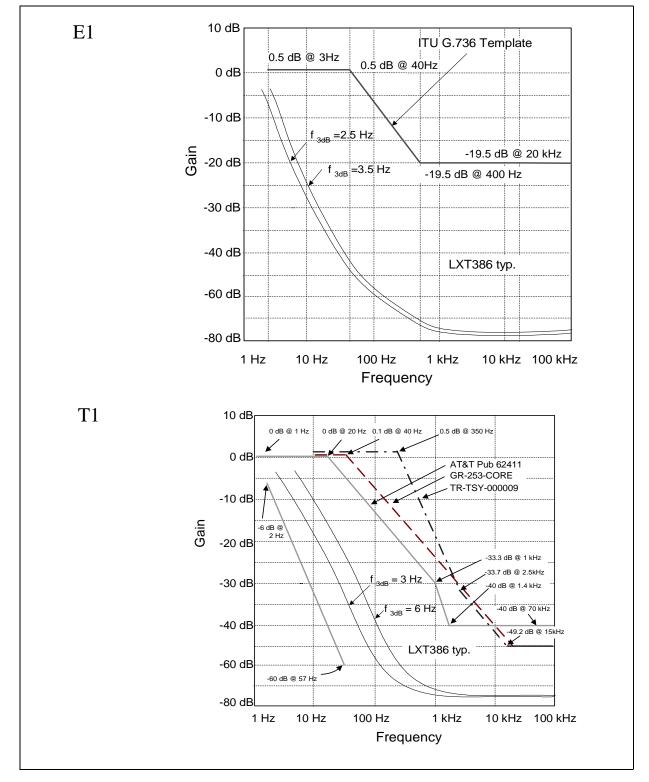


Figure 33. LXT386 Jitter Tolerance Performance



Figure 34. Jitter Transfer Performance



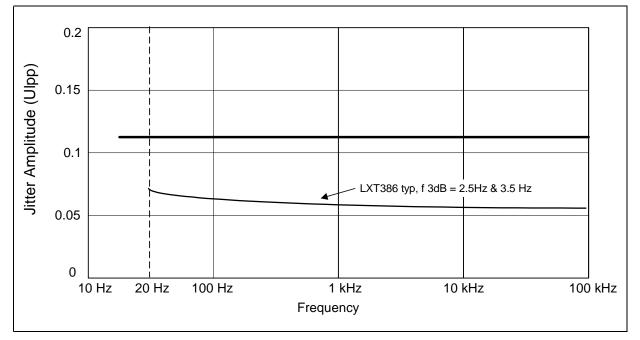


Figure 35. Output Jitter for CTR12/13 applications

### 6.1 Recommendations and Specifications

AT&T Pub 62411

ANSI T1.102 - 199X Digital Hierarchy Electrical Interface

ANSI T1.231 -1993 Digital Hierarchy Layer 1 In-Service Digital Transmission Performance Monitoring

Bellcore TR-TSY-000009 Asynchronous Digital Multiplexes Requirements and Objectives Bellcore GR-253-CORE SONET Transport Systems Common Generic Criteria

Bellcore GR-499-CORE Transport Systems Generic Requirements

G.703 Physical/electrical characteristics of hierarchical digital interfaces

G. 704 Functional characteristics of interfaces associated with network nodes

G.735 Characteristics of Primary PCM multiplex equipment operating at 2048 kbit/s and offering digital access at

384 kbit/s and/or synchronous digital access at 64 kbit/s

G.736 Characteristics of a synchronous digital multiplex equipment operating at 2048 kbit/s

G.772 Protected Monitoring Points provided on Digital Transmission Systems

G.775 Loss of signal (LOS) and alarm indication (AIS) defect detection and clearance criteria

G.783 Characteristics of Synchronous Digital Hierarchy (SDH) Equipment Functional Blocks

G.823 The control of jitter and wander within digital networks which are based on the 2048 kbit/ s hierarchy

O.151 Specification of instruments to measure error performance in digital systems

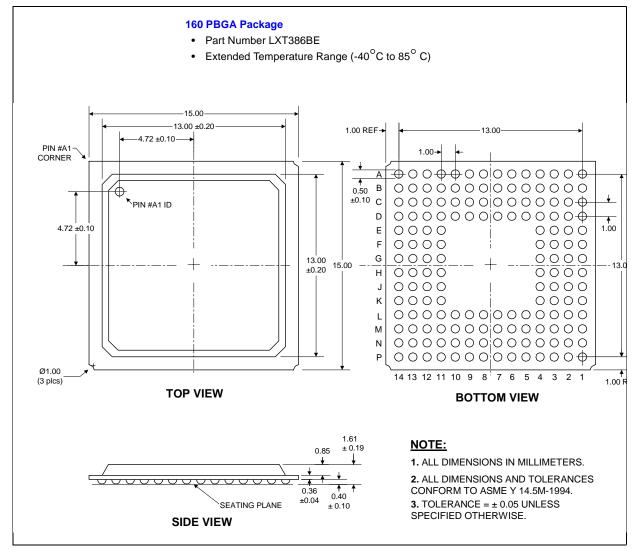
OFTEL OTR-001 Short Circuit Current Requirements

ETS 300166 Physical and Electrical Characteristics

ETS 300386-1 Electromagnetic Compatibility Requirement



## 7.0 Mechanical Specifications



#### Figure 36. 60 Plastic Ball Grid Array (PBGA) Package Dimensions

#### Figure 37. 100 Pin Low Quad Flat Packages (LQFP) Dimensions

